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IN REPLY
REFER TO

DSCC-VAC

08-October-04

MEMORANDUM FOR MILITARY/INDUSTRY DISTRIBUTION

SUBJECT: Initial Draft of MIL-M-38510/56 revision G; Project Number 5962-2067

The initial draft for this subject document, dated 08-October-04, is now available for viewing and downloading from the DSCC-VA Web site:

<http://www.dsc.dla.mil/Programs/MilSpec/DocSearch.asp>

The changes to this document are to update the document to the latest requirements of MIL-PRF-38535 and to reactivate the specification and update the boilerplate to the latest MIL-STD-961 revision E requirements.

Concurrence or comments are required at this Center within 45 days from the date of this letter. Late comments will be held for the next coordination of the document. Comments from military departments must be identified as either "Essential" or "Suggested". Essential comments must be justified with supporting data. Military review activities should forward comments to their custodians of this office, as applicable, in sufficient time to allow for consolidating the department reply.

The point of contact for this document is Mr. Joe Kerby, Defense Supply Center Columbus, DSCC-VAC, Post Office Box 3990, Columbus, OH 43218-3990. Mr. Kerby can also be reached at 614-692-0544/850-0544, or by facsimile 614-692-6939/850-6939, or by e-mail to: joseph.kerby@dla.mil.

/ signed /

Thomas M. Hess
Chief
Active Devices Team

cc:
VSC
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NOTE: This draft, dated 8 Oct. 2004, prepared by the Defense Supply Center Columbus (DSCC-VAC) has not been approved and is subject to modification. DO NOT USE PRIOR TO APPROVAL.
(Project 5962-2067)

INCH-POUND

MIL-M-38510/56G
DRAFT

SUPERSEDING
MIL-M-38510/56F
19 February 1988

MILITARY SPECIFICATION
MICROCIRCUITS, DIGITAL, CMOS, COUNTERS/DIVIDERS,
MONOLITHIC SILICON

Reactivated after xx xxxx. 2004 and may be used for new and existing designs and acquisitions.

This specification is approved for use by all Departments
and Agencies of the Department of Defense.

The requirements for acquiring the product herein consists of this specification sheet and MIL-PRF 38535

1. SCOPE

1.1 Scope. This specification covers the detail requirements for monolithic silicon, CMOS, logic microcircuits. Two product assurance classes and a choice of case outlines, lead finishes, and radiation hardness assurance (RHA) are provided and are reflected in the complete Part or Identifying Number (PIN). For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535 (see 6.3).

1.2 Part or identifying number (PIN). The PIN is in accordance with MIL-PRF-38535 and as specified herein.

1.2.1 Device types. The device types are as follows:

<u>Device type</u>	<u>Circuit</u>
01	Decade counter/divider
02	Presetable divide-by-"N" counter
03	14-stage ripple-carry binary counter/divider
04	Divide-by-8 counter/divider
05	7-stage binary counter
51	Decade counter/divider
52	Presetable divide-by-"N" counter
53	14-stage ripple-carry binary counter/divider
54	Divide-by-8 counter/divider
55	7-stage binary counter

1.2.2 Device class. The device class is the product assurance level as defined in MIL-PRF-38535.

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAC, P.O. Box 3990, Columbus, OH 43218-3990, or email CMOS@dscclia.mil. Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at www.dodssp.daps.mil.

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1.2.3 Case outlines. The case outlines are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
A	GDFP5-F14 or CDFP6-F14	14	Flat pack
B	GDFP4-F14	14	Flat pack
C	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
D	GDFP1-F14 or CDFP2-F14	14	Flat pack
E	GDIP1-T16 or CDIP2-T16	16	Dual-in-line
F	GDFP2-F16 or CDFP3-F16	16	Flat pack
N	CDFP4-T16	16	Flat pack
T	CDFP3-F14	14	Flat pack
X <u>1/</u> <u>2/</u>	GDFP5-F14 or CDFP6-F14	14	Flat pack, except A dimension equals 0.100" (2.54 mm) max
Y <u>1/</u> <u>2/</u>	GDFP1-F14 or CDFP2-F14	14	Flat pack, except A dimension equals 0.100" (2.54 mm) max
Z <u>1/</u> <u>2/</u>	GDFP2-F16 or CDFP3-F16	16	Flat pack, except A dimension equals 0.100" (2.54 mm) max

1.3 Absolute maximum ratings.

Supply voltage range ($V_{DD} - V_{SS}$):	
Device types 01, 02, 03, 04, and 05	-0.5 V dc to +15.5 V dc
Device types 51, 52, 53, 54, and 55	-0.5 V dc to +18.0 V dc
Input current (each input)	± 10 mA
Input voltage range.....	$(V_{SS} - 0.5 \text{ V}) \leq V_I \leq (V_{DD} + 0.5 \text{ V})$
Storage temperature range (T_{STG}).....	-65° to +175°C
Maximum power dissipation (P_D)	200 mW
Lead temperature (soldering, 10 seconds)	+300°C
Thermal resistance, junction to case (θ_{JC}).....	See MIL-STD-1835
Junction temperature (T_J)	175°C

1.4 Recommended operating conditions.

Supply voltage range ($V_{DD} - V_{SS}$):	
Device types 01, 02, 03, 04, and 05	4.5 V dc to 12.5 V dc
Device types 51, 52, 53, 54, and 55	4.5 V dc to 15.0 V dc
Input low voltage range (V_{IL}):	
Device types 01, 02, 03, 04, and 05	0.0 V to 0.85 V dc @ $V_{DD} = 5.0$ V dc 0.0 V to 2.0 V dc @ $V_{DD} = 10.0$ V dc 0.0 V to 2.1 V dc @ $V_{DD} = 12.5$ V dc
Device types 51, 52, 53, 54, and 55	$V_{OL} = 10\% V_{DD}$, $V_{OH} = 90\% V_{DD}$ 0.0 V to 1.5 V dc @ $V_{DD} = 5.0$ V dc 0.0 V to 2.0 V dc @ $V_{DD} = 10.0$ V dc 0.0 V to 4.0 V dc @ $V_{DD} = 15.0$ V dc
Input high voltage range (V_{IH}):	
Device types 01, 02, 03, 04, and 05	3.95 V to 5.0 V dc @ $V_{DD} = 5.0$ V dc 8.0 V to 10.0 V dc @ $V_{DD} = 10.0$ V dc 10 V to 12.5 V dc @ $V_{DD} = 12.5$ V dc
Device types 51, 52, 53, 54, and 55	$V_{OL} = 10\% V_{DD}$, $V_{OH} = 90\% V_{DD}$ 3.5 V to 5.0 V dc @ $V_{DD} = 5.0$ V dc 8.0 V to 10.0 V dc @ $V_{DD} = 10.0$ V dc 11.0 V to 15.0 V dc @ $V_{DD} = 15.0$ V dc
Load capacitance	50 pF maximum
Ambient operating temperature range (T_A)	-55°C to +125°C

- 1/ As an exception to nickel plate or undercoating paragraph of MIL-PRF-38535, appendix A, for case outlines X, Y, and Z only, the leads of bottom brazed ceramic packages (i.e., configuration 2 of case outline A, D, or F) may have electroless nickel undercoating which is 50 to 200 microinches (1.27 to 5.08 μm) thick provided the lead finish is hot solder dip (i.e., finish letter A) and provided that, after any lead forming, an additional hot solder dip coating is applied which extends from the outer tip of the lead to no more than 0.015 inch (0.38 mm) from the package edge.
- 2/ For bottom or side brazed packages, case outlines X, Y, and Z only, the S_1 dimension may go to .000 inch (.00 mm) minimum.

2. APPLICABLE DOCUMENTS

2.1 General. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

2.2 Government documents.

2.2.1 Specifications and Standards. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

(Copies of these documents are available online at <http://assist.daps.dla.mil/quicksearch/> or www.dodssp.daps.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 Order of precedence. In the event of a conflict between the text of this document and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Qualification. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).

3.2 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.3 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein. Although eutectic die bonding is preferred, epoxy die bonding may be performed. However, the resin used shall be Dupont 5504 Conductive Silver Paste, or equivalent, which is cured at 200°C ±10°C for a minimum of 2 hours. The use of equivalent epoxies or cure cycles shall be approved by the qualifying activity. Equivalency shall be demonstrated in data submitted to the qualifying activity for verification.

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3.3.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.3.2 Logic diagrams and functional waveforms. The logic diagrams and functional waveforms shall be as specified on figure 2.

3.3.3 Truth tables. The truth tables shall be as specified on figure 3.

3.3.4 Test procedures and test circuits. The test procedures and test circuits shall be as specified on figures 4 through 7.

3.3.5 Switching time waveforms and test circuit. The switching time waveforms and test circuit shall be as specified on figure 8.

3.3.6 Schematic circuits. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity or preparing activity upon request.

3.3.7 Case outlines. The case outlines shall be as specified in 1.2.3.

3.4 Lead material and finish. The lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).

3.5 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I, and apply over the full recommended case operating temperature range,.

3.6 Electrical test requirements. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.

3.7.1 Radiation hardness assurance identifier. The radiation hardness assurance identifier shall be in accordance with MIL-PRF-38535 and 4.5.4 herein.

3.8 Microcircuit group assignment. The devices covered by this specification shall be in microcircuit group number 40 (see MIL-PRF-38535, appendix A).

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 1/ $V_{SS} = 0\text{ V}$, $-55^{\circ}\text{C} \leq T_C \leq 125^{\circ}\text{C}$ unless otherwise specified	Device type	Limits		Unit
				Min	Max	
Positive clamping input to V_{DD}	V_{IC} (POS)	$T_C = 25^{\circ}\text{C}$, $V_{DD} = \text{GND}$, $V_{SS} = \text{Open}$, Output = Open, $I_I = 1\text{ mA}$	All		1.5	V
Negative clamping input to V_{SS}	V_{IC} (NEG)	$T_C = 25^{\circ}\text{C}$, $V_{DD} = \text{Open}$, $V_{SS} = \text{GND}$, Output = Open, $I_I = -1\text{ mA}$	All		-6	V
Quiescent supply current	I_{SS}	V_{DD} maximum, any combination of inputs	01,02,04, 05,51,52, 54,55		-5.0	μA
			03,53		-10.0	μA
High level output voltage	V_{OH}	$V_{DD} = 12.5\text{ V}$, no load, All outputs	01-05	11.25		V
		$V_{DD} = 5.0\text{ V}$, $I_{OH} = -21\text{ }\mu\text{A}$, DECODED outputs	01,04	4.5		V
		$V_{DD} = 5.0\text{ V}$, $I_{OH} = -105\text{ }\mu\text{A}$ CARRY output	01,04	4.5		V
		$V_{DD} = 5.0\text{ V}$, $I_{OH} = -40\text{ }\mu\text{A}$, Q_1 through Q_4 outputs	02	4.5		V
		$V_{DD} = 5.0\text{ V}$, $I_{OH} = -105\text{ }\mu\text{A}$, Q_5 output	02	4.5		V
		$V_{DD} = 5.0\text{ V}$, $I_{OH} = -65\text{ }\mu\text{A}$, All outputs	03	4.5		V
		$V_{DD} = 5.0\text{ V}$, $I_{OH} = -105\text{ }\mu\text{A}$, All outputs	05	4.5		V
		$V_{DD} = 15\text{ V}$, $I_{OH} = 0$	51-55	14.95		V
Low level output voltage	V_{OL}	$V_{DD} = 12.5\text{ V}$, No load, All outputs	01-05		1.25	V
		$V_{DD} = 5.0\text{ V}$, $I_{OL} = 35\text{ }\mu\text{A}$, DECODED outputs	01,04		500	mV
		$V_{DD} = 5.0\text{ V}$, $I_{OL} = 105\text{ }\mu\text{A}$ CARRY output	01,04		500	mV
		$V_{DD} = 5.0\text{ V}$, $I_{OL} = 35\text{ }\mu\text{A}$ Q_1 through Q_4 output	02		500	mV
		$V_{DD} = 5.0\text{ V}$, $I_{OL} = 105\text{ }\mu\text{A}$ Q_5 output	02		500	mV
		$V_{DD} = 5.0\text{ V}$, $I_{OL} = 90\text{ }\mu\text{A}$ All outputs	03		500	mV
		$V_{DD} = 5.0\text{ V}$, $I_{OL} = 175\text{ }\mu\text{A}$ All outputs	05		500	mV
		$V_{DD} = 15\text{ V}$, $I_{OL} = 0$	51-55		50	mV
Input high voltage	V_{IH}	$V_{DD} = 5\text{ V}$, see table III	01-05	3.6		V
		$V_{DD} = 5\text{ V}$, see table III	51-55	3.5		V

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions <u>1/</u> $V_{SS} = 0\text{ V}$, $-55^{\circ}\text{C} \leq T_C \leq 125^{\circ}\text{C}$ unless otherwise specified	Device type	Limits		Unit	
				Min	Max		
Input high voltage	V_{IH}	$V_{DD} = 10\text{ V}$, see table III	51-55	7.0		V	
		$V_{DD} = 15\text{ V}$, see table III	51-55	11.0		V	
Input low voltage	V_{IL}	$V_{DD} = 5\text{ V}$, see table III	01-05		0.85	V	
		$V_{DD} = 5\text{ V}$, see table III	51-55		1.5	V	
		$V_{DD} = 10\text{ V}$, see table III	51-55		3.0	V	
		$V_{DD} = 15\text{ V}$, see table III	51-55		4.0	V	
Output low (sink) current	I_{OL}	$V_{DD} = 5\text{ V}$, $V_{IN} = 0\text{ V}$ or 5 V , $V_{OL} = 0.4\text{ V}$	51-55	0.36		mA	
		$V_{DD} = 15\text{ V}$, $V_{IN} = 0\text{ V}$ or 15 V , $V_{OL} = 1.5\text{ V}$	51-55	2.4		mA	
Output high (source) current	I_{OH}	$V_{DD} = 5\text{ V}$, $V_{IN} = 0\text{ V}$ or 5 V , $V_{OH} = 4.6\text{ V}$	51-55	-0.36		mA	
		$V_{DD} = 15\text{ V}$, $V_{IN} = 0\text{ V}$ or 15 V , $V_{OH} = 13.5\text{ V}$	51-55	-2.4		mA	
Input leakage current <u>2/</u>	I_{IH}	Each input	$V_{DD} = 15\text{ V}$	01-05		100	nA
			$V_{DD} = 18\text{ V}$	51-55			
			$V_{DD} = 15\text{ V}$	01-05		-100	nA
			$V_{DD} = 18\text{ V}$	51-55			
Input capacitance	C_i	$V_{DD} = 0\text{ V}$, $f = 1\text{ MHz}$ $T_C = 25^{\circ}\text{C}$, any input	All		12	pF	
Propagation delay time, high-to-low level	t_{PHL}	$V_{DD} = 5.0\text{ V}$, CLOCK to DECODED outputs	01	.013	2.70	μs	
			51	"	1.40		
		$V_{DD} = 5.0\text{ V}$, RESET to DECODED outputs 1-9	01	"	2.70		
			51	"	1.40		
		$V_{DD} = 5.0\text{ V}$, CLOCK to CARRY output	01	"	2.18		
			51	"	1.12		
		$V_{DD} = 5.0\text{ V}$, CLOCK to Q_5 output	02	"	2.18		
			52	"	980		ns
$V_{DD} = 5.0\text{ V}$, CLOCK to $Q_1 - Q_4$ outputs	02	"	2.70	ns			
	52	"	980	ns			
Propagation delay time, high-to-low level, low-to-high level	t_{PHL} , t_{PLH}	$V_{DD} = 5.0\text{ V}$, CLOCK to	Q_1	03	"	1.34	μs
			Q_4	.052	5.25		
			Q_5	.065	6.68		
			Q_6	.078	8.03		
			Q_7	.091	9.30		
			Q_8	.104	10.65		
			Q_9	.117	12.15		
			Q_{10}	.130	13.35		
			Q_{11}	.143	14.85		
			Q_{12}	.156	16.05		
			Q_{13}	.169	17.40		
			Q_{14}	.182	18.75		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions 1/ $V_{SS} = 0\text{ V}$, $-55^{\circ}\text{C} \leq T_C \leq 125^{\circ}\text{C}$, unless otherwise specified	Device type	Limits		Unit				
				Min	Max					
Propagation delay time, high-to-low level	t_{PHL}	$V_{DD} = 5.0\text{ V}$, RESET to any output	03	.013	4.95	μs				
			53	.013	630	ns				
		$V_{DD} = 5.0\text{ V}$, CLOCK to CARRY output	04	.013	1.80	μs				
			54	.013	1.16					
		$V_{DD} = 5.0\text{ V}$, CLOCK to DECODED outputs	04	.013	3.38					
			54	.013	1.40					
$V_{DD} = 5.0\text{ V}$, RESET to DECODED outputs 1-7	04	.013	1.80							
	54	.013	1.40							
Propagation delay time, low-to-high level, high-to-low level	t_{PLH} , t_{PHL}	$V_{DD} = 5.0\text{ V}$, CLOCK to	Q_1	.013	0.66	μs				
			Q_2	.026	1.32					
			Q_3	.039	1.98					
			Q_4	.052	2.64					
			Q_5	.065	3.30					
			Q_6	.078	3.96					
			Q_7	.091	4.65					
	$V_{DD} = 5.0\text{ V}$, RESET to any output	05	.013	2.25	μs					
		55	13	490	ns					
Propagation delay time, low-to-high level	t_{PLH}	$V_{DD} = 5.0\text{ V}$, CLOCK to DECODED outputs	01	.013	2.70	μs				
			51	"	1.40					
		$V_{DD} = 5.0\text{ V}$, CLOCK to DECODED outputs	01	"	2.18					
			51	"	1.12					
		$V_{DD} = 5.0\text{ V}$, RESET to 0 output	01	"	2.70					
			51	"	1.40					
		$V_{DD} = 5.0\text{ V}$, RESET to CARRY output	01	"	2.18					
			51	"	1.12					
		$V_{DD} = 5.0\text{ V}$, CLOCK to Q_5 output	02	"	2.18					
		$V_{DD} = 5.0\text{ V}$, CLOCK to $Q_1 - Q_4$ outputs	02	"	2.70					
		$V_{DD} = 5.0\text{ V}$, CLOCK to $Q_1 - Q_5$ outputs	52	13	980	ns				
		$V_{DD} = 5.0\text{ V}$, RESET to Q_5 output	02	.013	2.70	μs				
		$V_{DD} = 5.0\text{ V}$, RESET to $Q_1 - Q_4$ outputs	02	.013	2.18					
$V_{DD} = 5.0\text{ V}$, RESET to $Q_1 - Q_5$ outputs	52	13	980	ns						
Propagation delay time, high-to-low level, low-to-high level	t_{PHL} , t_{PLH}	$V_{DD} = 5.0\text{ V}$, CLOCK to	Q_1	.013	0.77	μs				
			Q_4	.052	2.15					
			Q_5	.065	2.62					
			Q_6	.078	3.08					
			Q_7	.091	3.54					
			Q_8	.104	4.00					
			Q_9	.117	4.47					
			Q_{10}	.130	4.93					
			Q_{11}	.143	5.39					
			Q_{12}	.156	5.85					
			Q_{13}	.169	6.31					
			Q_{14}	.182	6.78					
			Propagation delay time, low-to-high level	t_{PLH}	$V_{DD} = 5.0\text{ V}$, CLOCK to CARRY output		04	.013	1.80	μs
							54	"	1.16	
$V_{DD} = 5.0\text{ V}$, CLOCK to DECODED outputs	04	"			3.38					
	54	"			1.40					
$V_{DD} = 5.0\text{ V}$, RESET to 0 output	04	"			3.38					
	54	"			1.40					
$V_{DD} = 5.0\text{ V}$, RESET to CARRY output	04	"			1.80					
	54	"			1.12					

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions 1/ $V_{SS} = 0\text{ V}$, $-55^{\circ}\text{C} \leq T_C \leq 125^{\circ}\text{C}$ unless otherwise specified		Device type	Limits		Unit
					Min	Max	
Propagation delay time, low-to-high level, high-to-low level	t_{PLH} , t_{PHL}	$V_{DD} = 5.0\text{ V}$, CLOCK to	Q ₁	55	.013	0.49	μs
			Q ₂		.026	0.77	
			Q ₃		.039	1.05	
			Q ₄		.052	1.33	
			Q ₅		.055	1.61	
			Q ₆		.078	1.89	
			Q ₇		.097	2.17	
Transition time, high- to-low level = transition time, low-to-high level	t_{THL} , t_{TLH}	$V_{DD} = 5.0\text{ V}$	CARRY output	01	10	825	ns
			DECODED outputs		.010	3.38	μs
	t_{THL}	$V_{DD} = 5.0\text{ V}$, CARRY and DECODED outputs	51,54	10	280	ns	
	t_{TLH}	$V_{DD} = 5.0\text{ V}$, CARRY and DECODED outputs	51,54	10	504	ns	
	t_{THL} , t_{TLH}	$V_{DD} = 5.0\text{ V}$	Q ₅ output	02	10	825	ns
			Q ₁ – Q ₅ outputs	02	.010	3.38	μs
			Q ₁ – Q ₄ outputs	52	10	350	ns
		$V_{DD} = 5.0\text{ V}$, all outputs		03	.010	1.73	μs
				53	10	280	ns
	t_{THL}	$V_{DD} = 5.0\text{ V}$, CARRY output and DECODED outputs	04	“	750	ns	
	t_{TLH}	$V_{DD} = 5.0\text{ V}$, CARRY output and DECODED outputs	04	“	900	ns	
	t_{THL}	$V_{DD} = 5.0\text{ V}$, all outputs		05	“	645	ns
				55	“	280	ns
	t_{TLH}	$V_{DD} = 5.0\text{ V}$, all outputs		05	“	1050	ns
			55	“	280	ns	
Minimum setup time, high-to-low level	t_{SHL}	$V_{DD} = 5.0\text{ V}$, CLOCK input to RESET or CLOCK enable (DECODED outputs)	01		1125	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to CLOCK ENABLE (CARRY, DECODED outputs)	51		336	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to RESET or CLOCK ENABLE (CARRY output)	01		750	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to RESET	51		560	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to RESET or PRESET ENABLE	02		1125	ns	
			52		560	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to data line	02		750	ns	
			52		280	ns	
Minimum set-up time, low-to-high level	t_{SLH}	$V_{DD} = 5.0\text{ V}$, CLOCK input to data line	02		750	ns	
			52		280	ns	
Minimum set-up time, high-to-low level	t_{SHL}	$V_{DD} = 5.0\text{ V}$, CLOCK input to CLOCK ENABLE or RESET	04		1125	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to CLOCK ENABLE	54		350	ns	
		$V_{DD} = 5.0\text{ V}$, CLOCK input to RESET	54		560	ns	
Minimum clock pulse width	t_{PH}	$V_{DD} = 5.0\text{ V}$ $V_{IH} = 5.0\text{ V}$	01,02,04		750	ns	
			51		350		
			52		700		
			54		550		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions <u>1/</u> $V_{SS} = 0 \text{ V}$, $-55^{\circ}\text{C} \leq T_C \leq 125^{\circ}\text{C}$ unless otherwise specified	Device type	Limits		Unit
				Min	Max	
Minimum data pulse width	t_{PH}	$V_{DD} = 5.0 \text{ V}$ $V_{IH} = 5.0 \text{ V}$	03		750	ns
			53		470	
			05		450	
			55		280	
Minimum preset pulse width	t_{PH}	$V_{DD} = 5.0 \text{ V}$ $V_{IH} = 5.0 \text{ V}$	02		750	ns
			52		560	
Minimum reset pulse width	t_{PH}	$V_{DD} = 5.0 \text{ V}$ $V_{IH} = 5.0 \text{ V}$	01,02		750	ns
			51,52		560	
			04,54		560	
			05		975	
			03		2.7	μs
			53		630	ns
Maximum clock frequency	f_{MAX}	$V_{DD} = 5.0 \text{ V}$ $C_L = 50 \text{ pF}$	03	650		kHz
			01,02,04	350		kHz
			51	1.43		MHz
			05,53,55	1.10		MHz
			52,54	0.71		MHz

1/ Complete terminal conditions shall be as specified in table III.

2/ Input current at one input node.

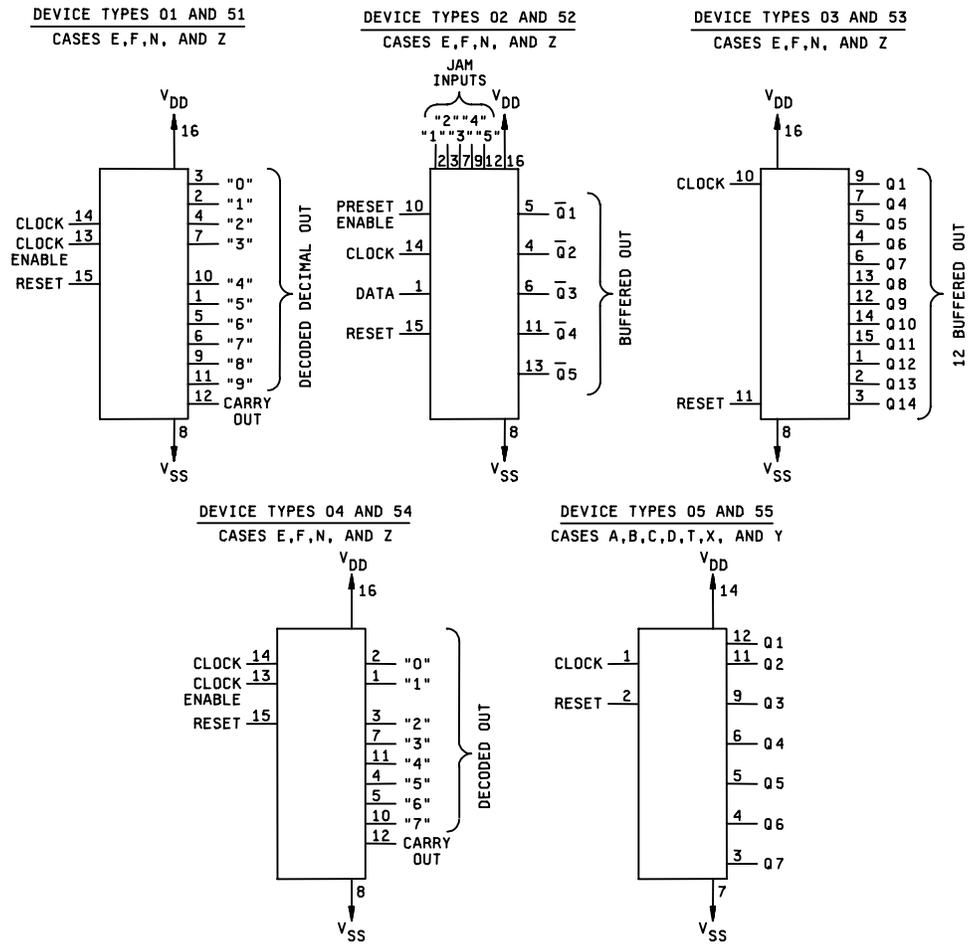


FIGURE 1. Terminal connections.

DEVICE TYPES 01 AND 51

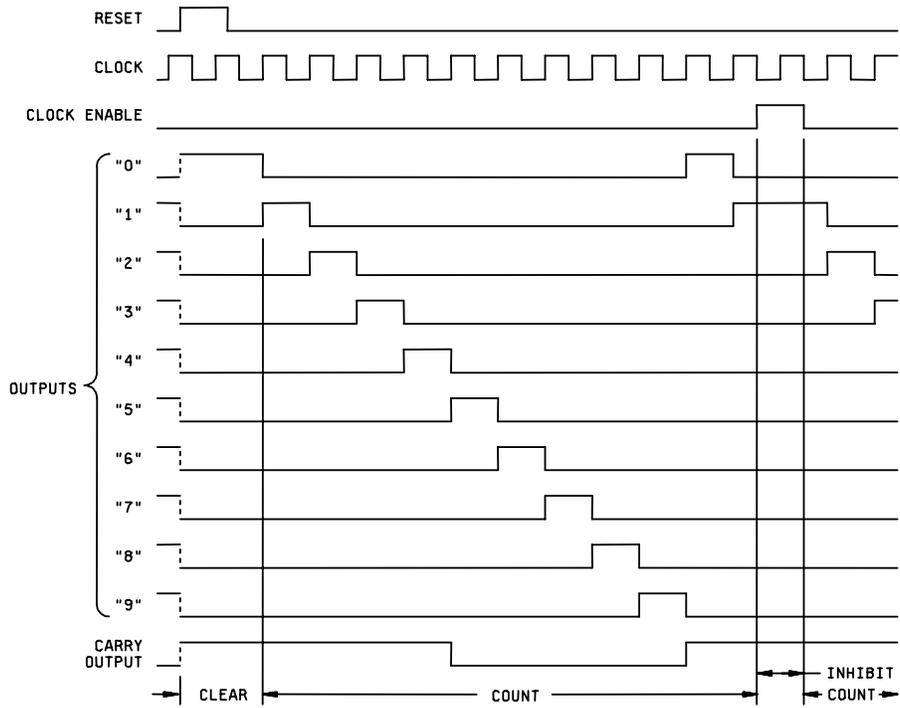
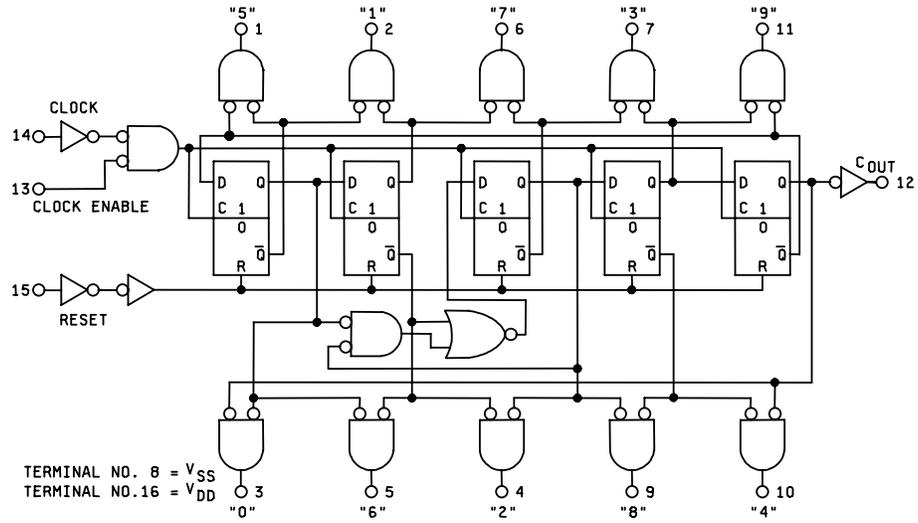


FIGURE 2. Logic diagrams and functional waveforms.

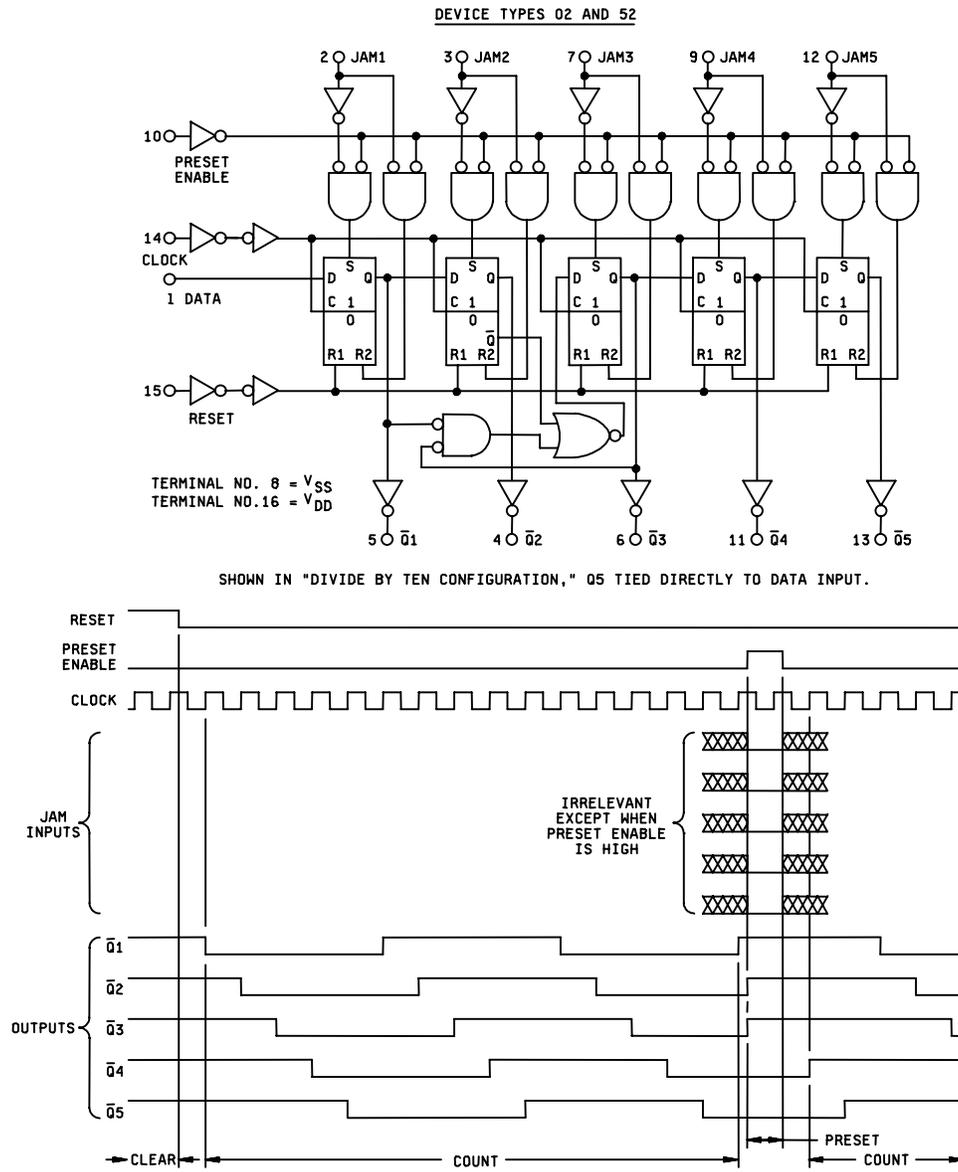


FIGURE 2. Logic diagrams and functional waveforms - Continued.

DEVICE TYPES 03 AND 53

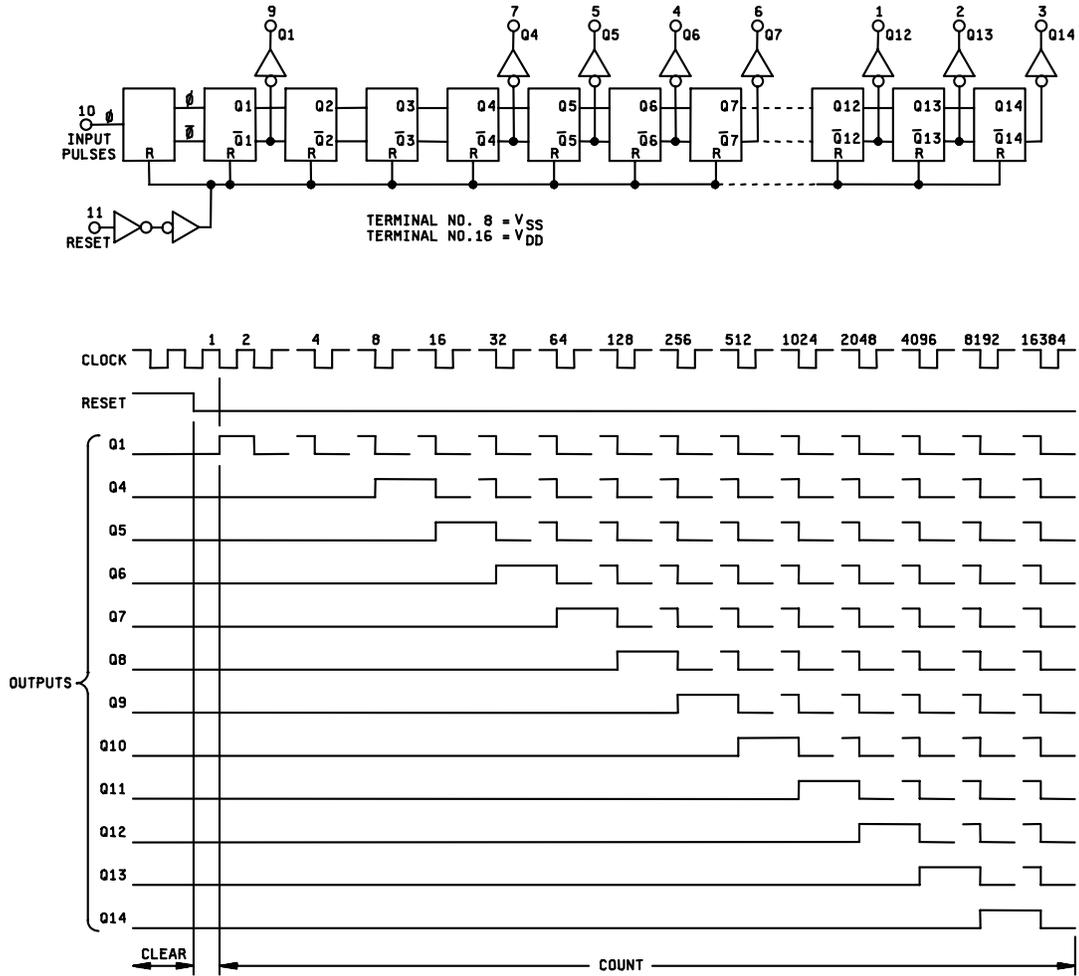


FIGURE 2. Logic diagrams and functional waveforms - Continued.

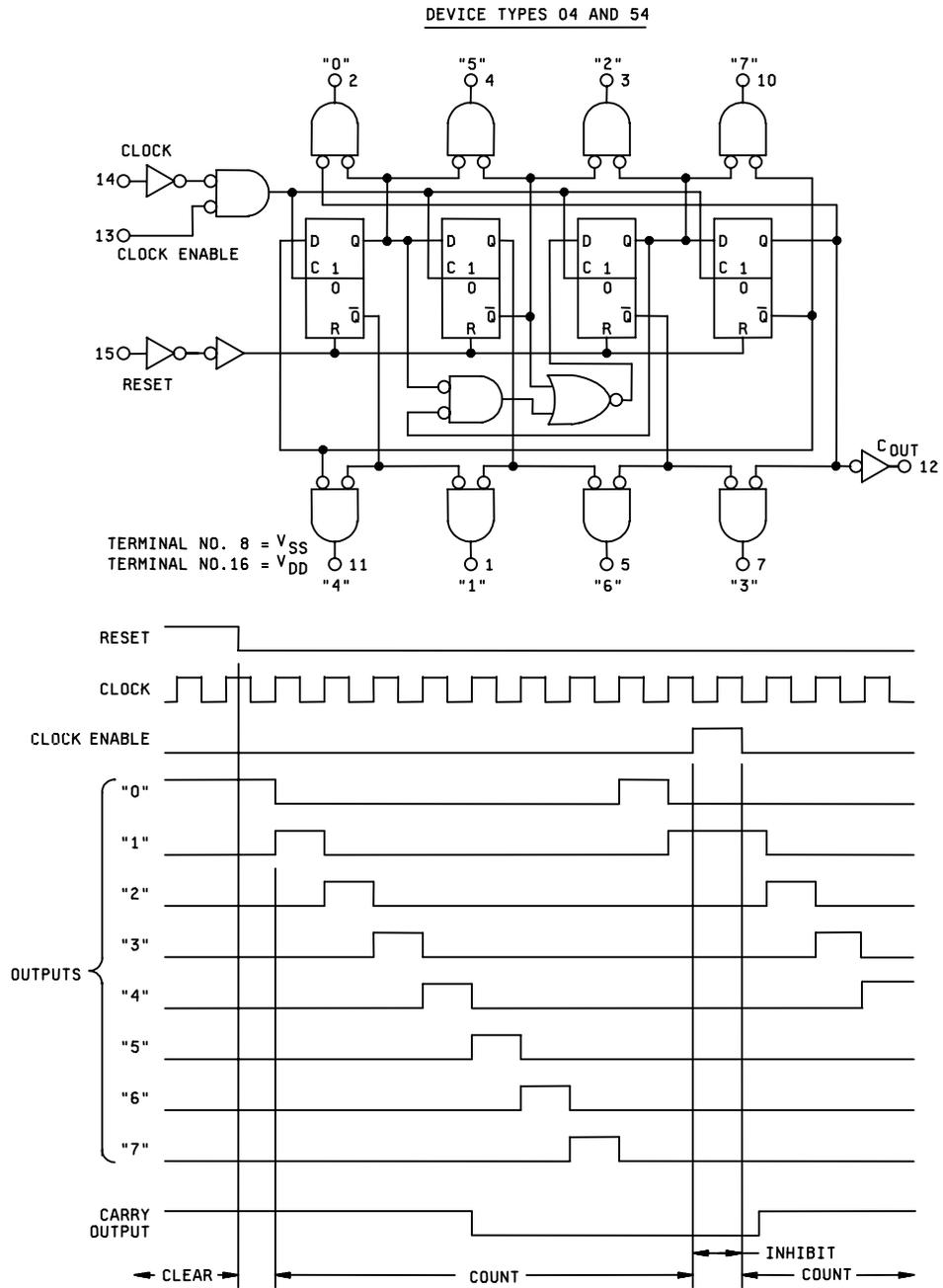


FIGURE 2. Logic diagrams and functional waveforms - Continued.

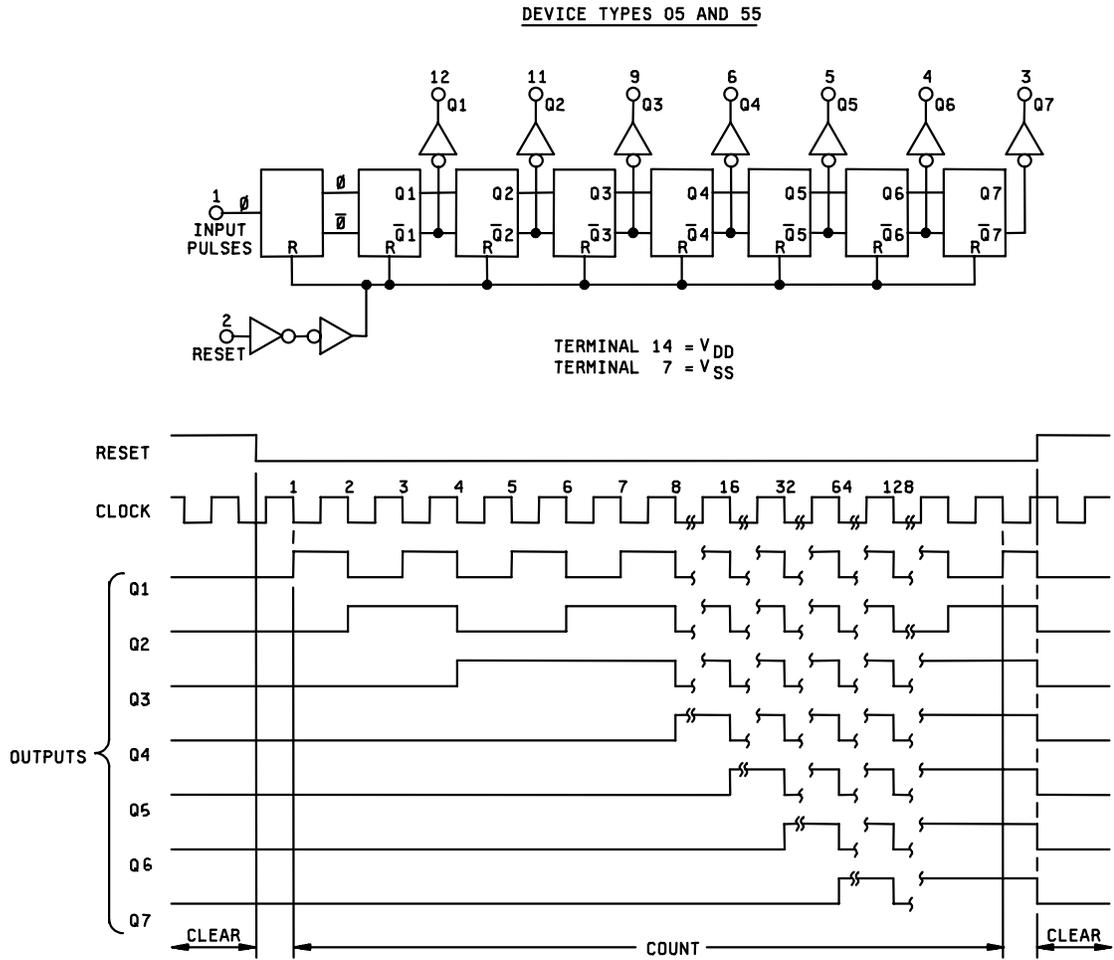


FIGURE 2. Logic diagrams and functional waveforms - Continued.

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Device types 01, 04, 51, 54

Inputs				Outputs		
CLOCK	CLOCK ENABLE	RESET	Dn-1	Qn	Nn	"On"
X	H	L	X	Qn-1	Nn-1	"On"-1 *
X	X	H	X	L	L	H
↓	X	L	X	Qn-1	Nn-1	"On"-1 *
↑	L	L	L	L	N-1n-1	"9n"-1
↑	L	L	H	H	N-1n-1	"9n"-1

N = Any decoded output, "1" through "9" for device types 01 and 51 and "1" through "7" for device types 04 and 54.

Device types 02 and 52

Inputs						Outputs	
CLOCK	RESET	DATA	PRESET ENABLE	JAM 1	JAM 2	$\overline{Q}1n$	$\overline{Q}Nn$
X	H	X	L	X	X	H	H
X	H	X	H	X	X	Invalid condition	
X	L	X	H	L	L	H	H
X	L	X	H	H	L	L	H
X	L	X	H	L	H	H	L
X	L	X	H	H	H	L	L
↓	L	X	L	X	X	$\overline{Q}1n-1$	$\overline{Q}Nn-1$ *
↑	L	L	L	X	X	H	$\overline{Q}N-1n-1$
↑	L	H	L	X	X	L	$\overline{Q}N-1n-1$

N = Any stage from 2 to 5.

Device types 03, 05, 53, and 55

Inputs		Output state
Data input	RESET	
L	L	No change
L	H	All outputs low
H	L	No change
H	H	All outputs low
↑	L	No change
↑	H	All outputs low
↓	L	Advance one count
↓	H	All outputs low

H = High level voltage.

L = Low level voltage.

* = No change.

↓ = Negative clock transition from time (n-1) to n.

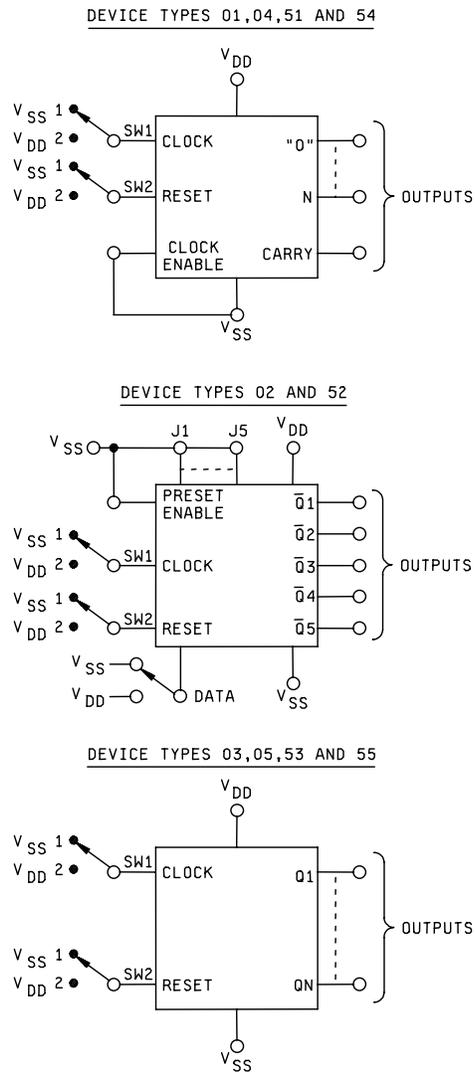
↑ = Positive clock transition from time (n-1) to n.

X = Irrelevant.

n = 1, 2, 3,, and is the input/clock counter after reset.

FIGURE 3. Truth tables.

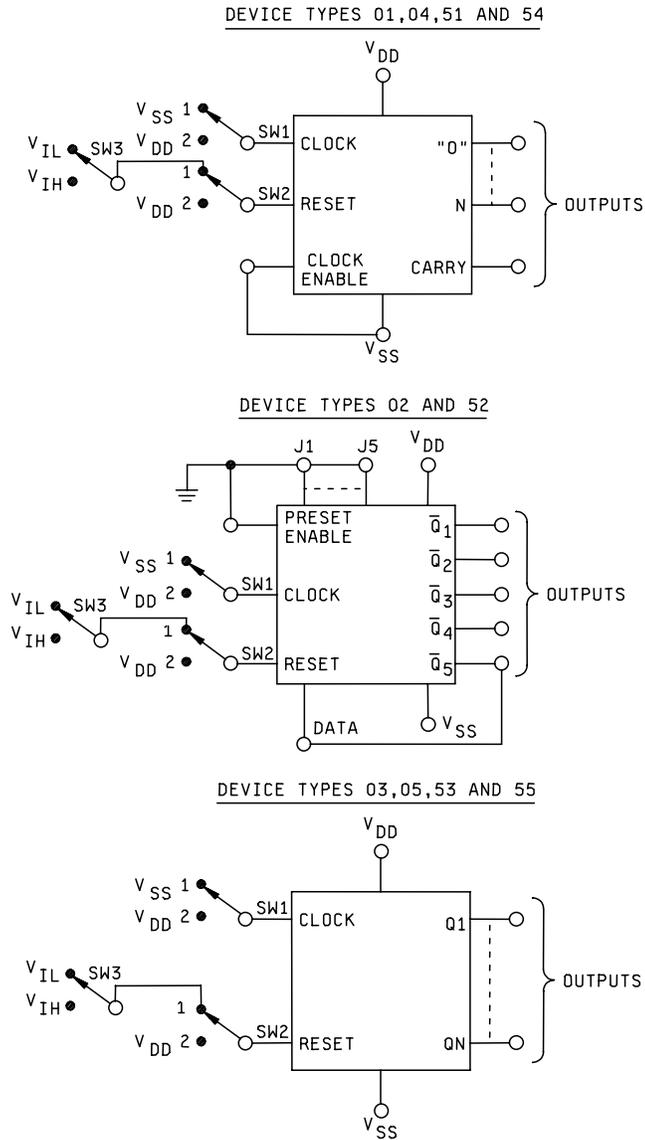
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NOTES:

1. Each output shall be measured as specified in table III.
2. For device types 01 through 05, the input-output voltage subscript numbers (V_{IH1} , V_{OH1} , etc.) are matched for each test. Each applicable load current is specified in table III.
3. See figure 2 for logic diagram and functional waveform.
4. To step counter through its sequence, momentarily place SW2 in position 2, then with SW1 increment counter to the the correct output logic state for measurements. Set device type 02 DATA input high or low to achieve correct input.

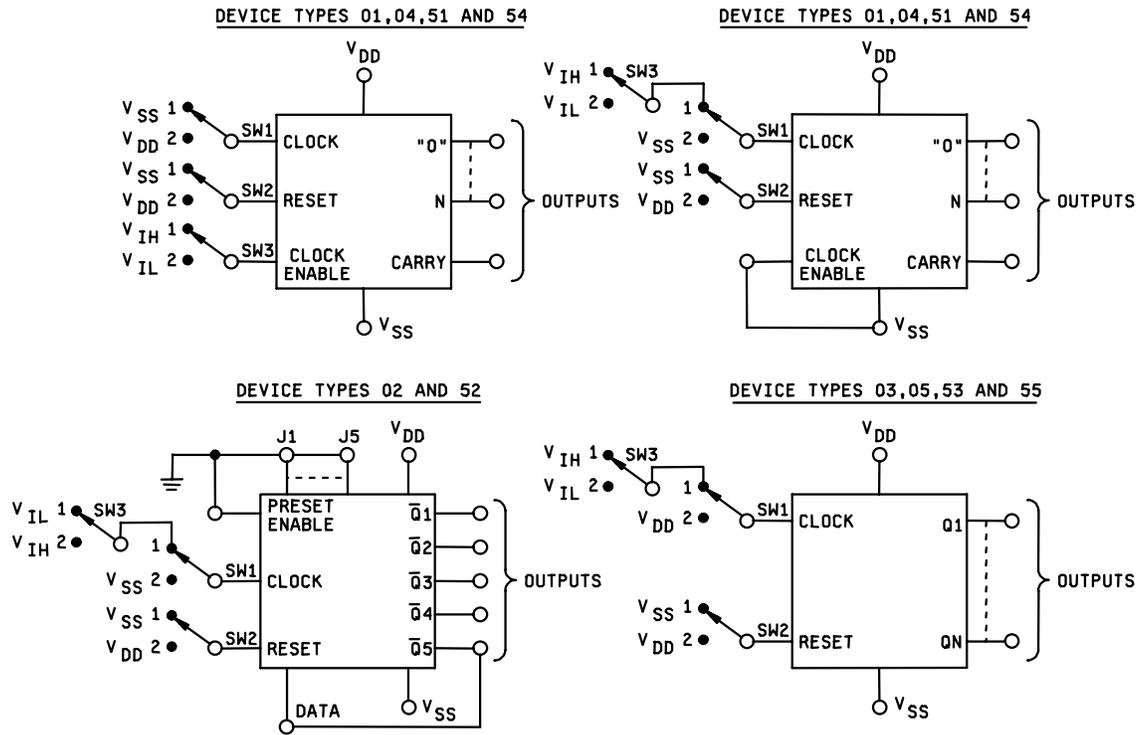
FIGURE 4. Test procedures and test circuits for output voltage and current measurements.



NOTES:

1. All outputs shall be checked for proper operation as specified in table III.
2. To step counter through its sequence, momentarily place SW2 in position 2, then with SW3 in the required logic position, toggle SW1 to increment counter.
3. See figure 2 for logic diagram and functional waveform.
4. Test requirements are considered met if counter returns to its zero count whenever SW3 is momentarily placed in position 2. Further, when SW3 is in position 2, counter will not advance but advances when SW3 is in position 1.

FIGURE 5. Test procedures and test circuits for RESET input voltage tests.

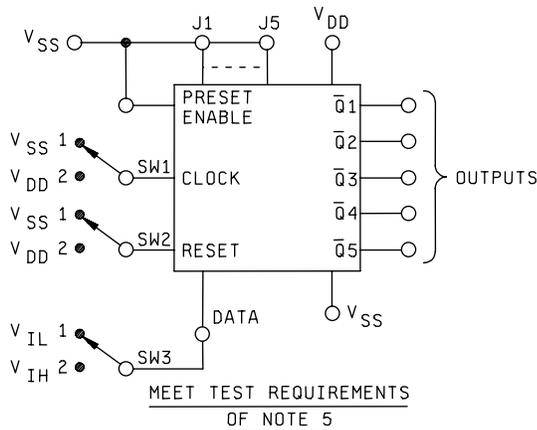
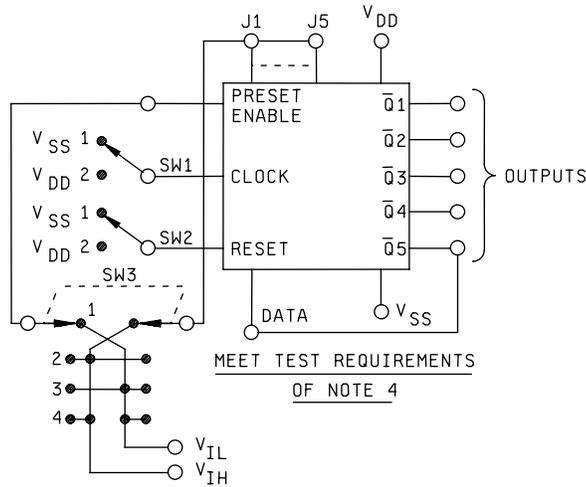


NOTES:

1. All outputs shall be checked for proper operation as specified in table III.
2. To step counter through its sequence, momentarily place SW2 in position 2, then with SW3 in the required logic position, toggle SW1 to increment counter.
3. See figure 2 for logic diagram and functional waveform.
4. Test requirements are considered met, if counter advances when SW3 is in position 2 but does not advance when SW3 is in position 1.

FIGURE 6. Test procedures and test circuits for CLOCK and CLOCK ENABLE input voltage tests.

DEVICE TYPES 02 AND 52



NOTES:

1. All outputs shall be checked for proper operation as specified in table III.
2. To step counter through its sequence, momentarily place SW2 in position 2, then with SW3 in the required logic position, toggle SW1 to increment counter.
3. See figure 2 for logic diagram and functional waveform.
4. Test requirements are considered met if: (a) counter advances with SW3 in positions 1 and 3; (b) all counter outputs are logic "L" with SW3 in position 2; and (c) all counter outputs are logic "H" with SW3 in position 4.
5. Test requirements are considered met if, with SW3 in position 1, the counter advances to a full count during 5 clock periods with outputs achieving logic "H". At this point, SW3 is changed to position 2 and after 5 more clock periods, a full count shall be registered with outputs achieving logic "L".

FIGURE 7. Test procedures and test circuits for JAM, PRESET ENABLE, and DATA input voltage tests.

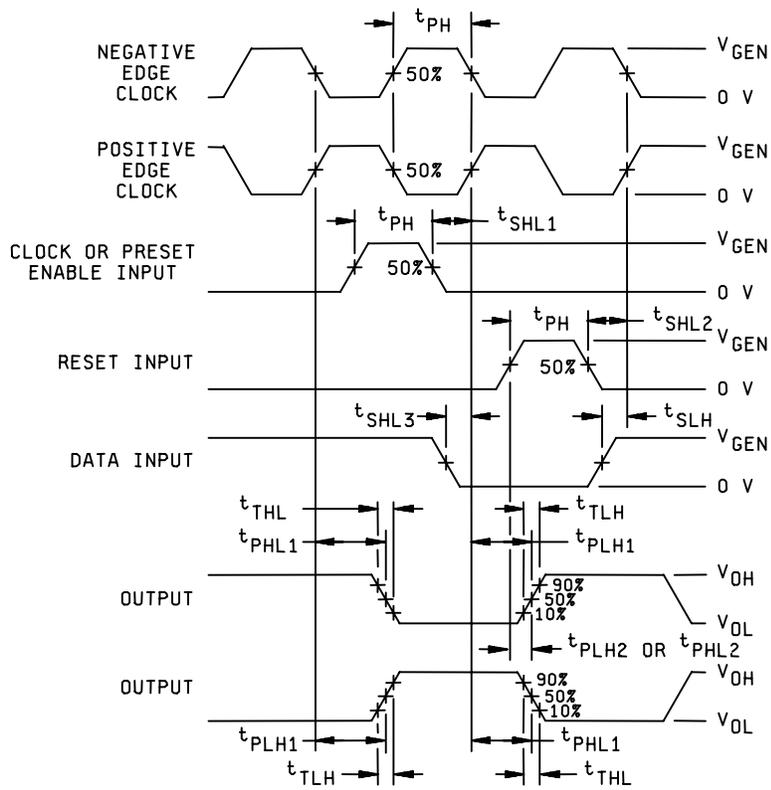
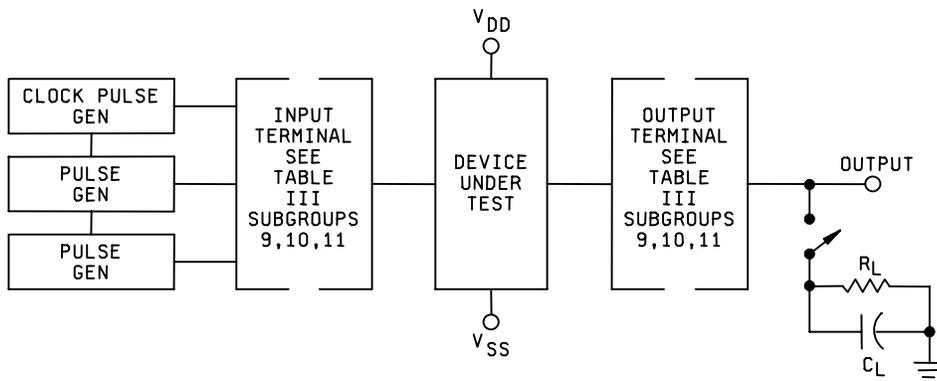


FIGURE 8. Switching time waveforms and test circuit.

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Test	Input terminal	Device type	Generator pulse conditions							Load		
			V _{GEN}	PRR at °C		t _{THL} ≤	t _{TLH} ≤	Duty cycle %	t _{PH} at °C		R _L kΩ ±10%	C _L pF
				+25, -55	+125				+25, -55 ≤	125 ≤		
t _{PLH} , t _{PHL} CLOCK to output	CLOCK *	01, 02, 04	5.0 V	450 kHz	350 kHz	15 ns	15 ns	50			200	50
		52, 54	5.0 V	995 kHz	710 kHz	15 ns	15 ns	50			200	50
		03	5.0 V	850 kHz	650 kHz	15 ns	15 ns	50			200	50
		51	5.0 V	2.0 MHz	1.43 MHz	15 ns	15 ns	50			200	50
		05, 53, 55	5.0 V	1.5 MHz	1.1 MHz	15 ns	15 ns	50			200	50
t _{PLH} , t _{PHL} RESET to output	RESET *	01, 02	5.0 V			30 ns	30 ns		500 ns	750 ns	200	50
	CLOCK	01, 02	5.0 V			15 ns	15 ns		1.111 μs	1.429 μs	200	50
	RESET *	03	5.0 V			30 ns	30 ns		1.8 μs	2.7 μs	200	50
	CLOCK	03	5.0 V			15 ns	15 ns		588 ns	769 ns	200	50
	RESET *	04	5.0 V			30 ns	30 ns		400 ns	560 ns	200	50
	CLOCK	04	5.0 V			15 ns	15 ns		1.111 μs	1.429 μs	200	50
	RESET *	05	5.0 V			30 ns	30 ns		650 ns	975 ns	200	50
	CLOCK	05	5.0 V			15 ns	15 ns		333 ns	455 ns	200	50
	RESET *	52, 54	5.0 V			30 ns	30 ns		400 ns	560 ns	200	50
	CLOCK	52, 54	5.0 V			15 ns	15 ns		503 ns	704 ns	200	50
	RESET *	51	5.0 V			30 ns	30 ns		400 ns	560 ns	200	50
	CLOCK	51	5.0 V			15 ns	15 ns		250 ns	350 ns	200	50
	RESET *	53	5.0 V			30 ns	30 ns		450 ns	630 ns	200	50
	CLOCK	53	5.0 V			15 ns	15 ns		333 ns	455 ns	200	50
	RESET *	55	5.0 V			30 ns	30 ns		350 ns	490 ns	200	50
CLOCK	55	5.0 V			15 ns	15 ns		333 ns	455 ns	200	50	

FIGURE 8. Switching time waveforms and test circuit – Continued.

Test	Input terminal	Device type	Generator pulse conditions							Load		
			V _{GEN}	PRR at °C		t _{THL} ≤	t _{TLH} ≤	Duty cycle %	t _{PH} at °C		R _L kΩ ±10%	C _L pF
				+25, -55	+125				+25, -55 ≤	125 ≤		
t _{SLH} , t _{SHL} Input to CLOCK	CLOCK	51	5.0 V	1.876 MHz	1.34 MHz	15 ns	15 ns	50				
	CLOCK	54	5.0 V	995 kHz	710 kHz	15 ns	15 ns	50				
	RESET or * CLOCK ENABLE	01, 04, 51, 54	5.0 V			15 ns			1.0 μs min	1.0 μs min		
	CLOCK	01, 04	5.0 V	450 kHz	350 kHz	15 ns	15 ns	50				
	RESET or * CLOCK ENABLE	02, 52	5.0 V			30 ns			1.0 μs min	1.0 μs min		
	CLOCK	02	5.0 V	450 kHz	350 kHz	15 ns	15 ns	50				
	CLOCK	52	5.0 V	995 kHz	710 kHz	15 ns	15 ns	50				
	DATA	52	5.0 V	834 kHz	595 kHz	15 ns	15 ns	50				
	DATA	02	5.0 V	225 kHz	175 kHz	15 ns	15 ns	50				
	RESET	02, 52	5.0 V			30 ns	30 ns		1.0 μs min	1.0 μs min		
	CLOCK	52	5.0 V	995 kHz	710 kHz	15 ns	15 ns	50				
	CLOCK	02	5.0 V	450 kHz	350 kHz	15 ns	15 ns	50				

NOTES:

1. Test conditions grouped by double horizontal lines are simultaneously applicable to the test being performed.
2. Unless otherwise specified, test each output separately.
3. "C_L" conditions include probe and wiring capacitance.
4. Apply input pulses as shown in abbreviated waveforms. See figure 2 for complete functional waveforms.
5. Setup times (t_{SHL} and t_{SLH}) are set to the maximum values given in the test limits columns of table III. Setup time test requirements are considered met if counters advance in the next actuating transition of the clock pulse following the negative transition of the reset, clock enable, or preset enable pulse. Device types 02, 52 "data" of the "data" input logic level with the next positive transition of the clock pulse after a "data" input logic change.
6. For device types 02 and 52, the "Q5" output is connected to the "data" input in all switching time tests except the "data" setup time test.
7. The inputs marked with an asterisk designate the measured terminal.
8. Duty cycle and PRR, although not relevant for real-time measurements, are specified to accommodate other measurement techniques.

FIGURE 8. Switching time waveforms and test circuit – Continued.

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38535 and shall be conducted on all devices prior to qualification and conformance inspection. The following additional criteria shall apply:

- a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- b. Delete the sequence specified as interim (pre-burn-in) electrical parameters through interim (post-burn-in) electrical parameters of table IA of MIL-PRF-38535 and substitute lines 1 through 7 of table II herein.
- c. Burn-in (method 1015 of MIL-STD-883).
 - (1) Unless otherwise specified in the manufacturers QM plan for static tests (test condition A), ambient temperature (T_A) shall be +125°C minimum. Test duration for each static test shall be 24 hours minimum for class S devices and in accordance with table I of method 1015 for class B devices.
 - i. For static burn-in I, all inputs shall be connected to 0.0 V.
 - ii. For static burn-in II, all inputs shall be connected to V_{DD} .
 - iii. Except for V_{DD} and V_{SS} , the terminal shall be connected through resistors whose value is 2 k Ω to 47 k Ω . The actual measured value of the resistor selected shall not exceed $\pm 20\%$ of its branded value due to use, heat or age.
 - iv. Output may be open or connected to $V_{DD}/2$.
 - v. $V_{DD} = 12.5$ V minimum, 15 V maximum for device types 01, 02, 03, 04, and 05.
 $V_{DD} = 15$ V minimum, 18 V maximum for device types 51, 52, 53, 54, and 55.
 $V_{DD}/2 = V_{DD}/2 \pm 1.0$ V for all devices.
 $V_{SS} = 0.0$ V.
 - (2) Unless otherwise specified in the manufacturers QM plan for dynamic test (test condition D), ambient temperature shall be +125°C minimum. Test duration shall be in accordance with table I of method 1015.
 - i. Except for V_{DD} and V_{SS} , the terminals shall be connected through resistors whose value is 2 k Ω to 47 k Ω . The actual measured value of the resistor selected shall not exceed $\pm 20\%$ of its branded value due to use, heat or age.
 - ii. Input signal requirements: Square wave, 50% duty cycle; 25 kHz < PRR < 1 MHz; t_{TLH} and $t_{THL} < 1$ μ s. Voltage level: Minimum = $V_{SS} - 0.5$ V, +10% V_{DD} ;
Maximum = $V_{DD} + 0.5$ V, -10% V_{DD} .
 - iii. $V_{DD} = 12.5$ V minimum, 15 V maximum for device types 01, 02, 03, 04, and 05.
 $V_{DD} = 15$ V minimum, 18 V maximum for device types 51, 52, 53, 54, and 55.
 $V_{DD}/2 = V_{DD}/2 \pm 1.0$ V.
 $V_{SS} = 0.0$ V.

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- d. Interim and final electrical test parameters shall be as specified in table II.
- e. For class S devices, post dynamic burn-in, or class B devices, post static burn-in, electrical parameter measurements may, at the manufacturer's option, be performed separately or included in the final electrical parameter requirements.

TABLE II. Electrical test requirements.

Line no.	MIL-PRF-38535 test requirements	Class S device ^{1/}			Class B device ^{1/}		
		Ref. par.	Table III Subgroups ^{2/}	Table IV delta limits ^{3/}	Ref. par.	Table III subgroups ^{2/}	Table IV delta limits ^{3/}
1	Interim electrical parameters		1			1	
2	Static burn-in I (method 1015)	4.2c 4.5.2					
3	Same as line 1		1	Δ			
4	Static burn-in II (method 1015)	4.2c 4.5.2			4.2c 4.5.2	<u>4/</u>	
5	Same as line 1	4.2e	1*	Δ	4.2e	1*	Δ
6	Dynamic burn-in (method 1015)	4.2c 4.5.2					
7	Same as line 1	4.2e	1*	Δ			
8	Final electrical parameters (method 5004)		1*, 2, 3, 7, 9			1*, 2, 3, 7, 9	
9	Group A test requirements (method 5005)	4.4.1	1, 2, 3, 4, 7, 9, 10, 11		4.4.1	1, 2, 3, 4, 7, 9, 10, 11	
10	Group B test when using method 5005 QCI option	4.4.2	1, 2, 3, 7, 9, 10, 11	Δ			
11	Group C end-point electrical parameters (method 5005)				4.4.3	1, 2, 3	Δ
12	Group D end-point electrical parameters (method 5005)	4.4.4	1, 2, 3		4.4.4	1, 2, 3	

^{1/} Blank spaces indicate tests are not applicable.

^{2/} * indicates PDA applies to subgroup 1 (see 4.2.1).

^{3/} Δ indicates delta limits shall be required only on table III subgroup 1, where specified, and the delta values shall be computed with reference to the previous interim electrical parameters.

^{4/} The device manufacturer may at his option either perform delta measurements or within 24 hours after burn-in (or removal of bias) perform the final electrical parameter measurements.

4.2.1 Percent defective allowable (PDA).

- a. The PDA for class S devices shall be 5 percent for static burn-in and 5 percent for dynamic burn-in, based on the exact number of devices submitted to each separate burn-in.
- b. Static burn-in I and II failure shall be cumulative for determining the PDA.
- c. The PDA for class B devices shall be in accordance with MIL-PRF-38535 for static burn-in. Dynamic burn-in is not required.
- d. Those devices whose measured characteristics, after burn-in, exceed the specified delta (Δ) limits or electrical parameter limits specified in table III, subgroup 1, are defective and shall be removed from the lot. The verified failures divided by the total number of devices in the lot initially submitted to burn-in shall be used to determine the percent defective for the lot and the lot shall be accepted or rejected based on the specified PDA.

4.3 Qualification inspection. Qualification inspection shall be in accordance with MIL-PRF-38535.

4.3.1 Qualification extension. When authorized by the qualifying activity for qualification inspection, if a manufacturer qualifies to a 51-55 device type which is manufactured identically to a 01 - 05 device type on this specification, then the 01- 05 device type may be part I qualified by conducting only worse case group A electrical tests and any electrical tests specified as additional group C subgroups and submitting data in accordance with MIL-PRF-38535.

4.4 Technology Conformance inspection (TCI). Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).

4.4.1 Group A inspection. Group A inspection shall be in accordance with table III of MIL-PRF-38535 and as follows:

- a. Tests shall be performed in accordance with table II herein.
- b. Subgroups 5, 6, and 8 shall be omitted.
- c. Subgroup 4 (C_I measurement) shall be measured only for initial qualification and after process or design changes that may affect input capacitance. Capacitance shall be measured between the designated terminal and V_{SS} at a frequency of 1 MHz.
- d. Subgroups 9 and 11 shall be measured only for initial qualification and after process or design changes which may affect dynamic performance.
- e. At the manufacturers option, test tapes may be programmed simultaneously for each identical section provided that each output is measured and each specified input combination is tested.
- f. When device types 01 through 05 are qualified by extension (see 4.3.1), these device types will be inspected (QCI) according to the requirements for device types 51 through 55, respectively.

4.4.2 Group B inspection. Group B inspection shall be in accordance with table II of MIL-PRF-38535.

4.4.3 Group C inspection. Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:

- a. End-point electrical parameters shall be as specified in table II herein. Delta limits shall apply only to subgroup 1 of group C inspection and shall consist of tests specified in table IV herein.
- b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
- c. When device types 01 through 05 are qualified by extension (see 4.3.1), these device types will be inspected (QCI) according to the requirements for device types 51 through 55, respectively.

TABLE III. Group A inspection for device type 01.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 4/														Measured terminal	Limits						Unit			
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		15	16	Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C			Subgroup 3 T _C = -55°C		
			Test no.	5 OUT	1 OUT	0 OUT	2 OUT	6 OUT	7 OUT	3 OUT	V _{SS}	8 OUT	4 OUT	9 OUT	CARRY OUT	CLOCK ENABLE		CLOCK	RESET	V _{DD}	Min	Max	Min		Max	Min	Max
V _{IC} (POS)		1													1 mA	1 mA	1 mA	GND	EACH INPUT		1.5					V	
V _{IC} (NEG)		2								GND					-1 mA	-1 mA	-1 mA		EACH INPUT		-6.0					V	
I _{IL1} 6/	3009	3													GND	GND	GND	15.0 V	ALL INPUTS TOGETHER		-300.0					nA	
I _{IL2}	3009	4													GND	GND	GND	"	EACH INPUT		-100.0		-100.0			"	
I _{IH1}	3010	5													15.0 V	15.0 V	15.0 V	"	ALL INPUTS TOGETHER		300.0					"	
I _{IH2}	3010	6													15.0 V	15.0 V	15.0 V	"	EACH INPUT		100.0		100.0			"	
V _{OH1} 1/ 2/	3006	7	I _{OH1}	I _{OH1}	I _{OH1}	I _{OH1}	I _{OH1}	I _{OH1}	I _{OH1}	I _{OH1}	"	I _{OH1}	I _{OH1}	I _{OH1}	I _{OH2}	IN	IN	IN	5.0 V	EACH OUTPUT	4.5		4.5		4.5		V
V _{OL1}	3007	8	I _{OL1}	I _{OL1}	I _{OL1}	I _{OL1}	I _{OL1}	I _{OL1}	I _{OL1}	I _{OL1}	"	I _{OL1}	I _{OL1}	I _{OL1}	I _{OL2}	"	"	"	5.0 V	EACH OUTPUT		500		500		500	mV
V _{OH2}	3006	9	OUT	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	OUT	OUT	OUT	"	"	"	12.5 V	EACH OUTPUT	11.25		11.25		11.25		V
V _{OL2}	3007	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	12.5 V	EACH OUTPUT		1.25		1.25		1.25	"
V _{IL} 1/ 2/	Fig. 6	11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	5.0 V	CLOCK ENABLE	1.10		0.85		1.35		"
V _{IH}	"	12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	CLOCK ENABLE		3.80		3.60		3.95	"
V _{IL}	"	13	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	CLOCK	1.10		0.85		1.35		"
V _{IH}	"	14	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	CLOCK		3.80		3.60		3.95	"
V _{IL}	Fig. 5	15	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	RESET	1.10		0.85		1.35		"
V _{IH}	Fig. 5	16	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	RESET		3.80		3.60		3.95	"
V _{SS} 3/	3005	17													GND	GND	15.0 V	15.0 V	V _{SS}		-0.5		-5.0			μA	
"	"	18													"	GND	GND	"	V _{SS}		"		"			"	
"	"	19													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	20													"	GND	"	"	None		"		"			"	
"	"	21													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	22													"	GND	"	"	V _{SS}		"		"			"	
"	"	23													"	15.0 V	"	"	None		"		"			"	
"	"	24													"	GND	"	"	V _{SS}		"		"			"	
"	"	25													"	15.0 V	"	"	None		"		"			"	
"	"	26													"	GND	"	"	V _{SS}		"		"			"	
"	"	27													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	28													"	GND	"	"	None		"		"			"	
"	"	29													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	30													"	GND	"	"	None		"		"			"	
"	"	31													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	32													"	GND	"	"	None		"		"			"	
"	"	33													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	34													"	GND	"	"	None		"		"			"	
"	"	35													"	15.0 V	"	"	V _{SS}		"		"			"	
"	"	36													15.0V	15.0 V	"	"	V _{SS}		"		"			"	

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 01 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 4/														Measured terminal	Limits						Unit					
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		15	16	Subgroup 4 T _C = 25°C		Limits							
			Test no.	5 OUT	1 OUT	0 OUT	2 OUT	6 OUT	7 OUT	3 OUT	V _{SS}	8 OUT	4 OUT	9 OUT	CARRY OUT	CLOCK ENABLE		CLOCK	RESET	V _{DD}	Min	Max	Min		Max	Min	Max		
C ₁ 2/	3012	37																		EACH INPUT		12.0					pF		
																							Subgroup 7 T _C = 25°C		Subgroup 8				
																					Min	Max	T _C = 125°C		T _C = -55°C				
Truth table test 3/	3014	38	L	L	H	L	L	L	L	GND	L	L	L	H	GND	5.0 V	5.0 V	5.0 V	EACH OUTPUT										
		39	L	L	H	L	L	L	L	L	L	L	L	H	L	5.0 V	5.0 V	5.0 V											
		40	L	L	H	L	L	L	L	L	L	L	L	H	L	5.0 V	GND	5.0 V											
		41	L	L	L	H	L	L	L	L	L	L	L	H	L	"	"	"											
		42	L	L	L	L	L	L	L	L	L	L	L	H	L	"	"	"											
		43	L	L	L	L	L	L	L	L	L	L	L	H	L	"	"	"											
		44	H	L	L	L	L	L	L	L	L	L	L	L	L	"	"	"											
		45	L	L	L	L	L	H	L	L	L	L	L	L	L	"	"	"											
		46	L	L	L	L	L	L	H	L	L	L	L	L	L	"	"	"											
		47	L	L	L	L	L	L	L	L	L	L	L	L	L	"	"	"											
		48	L	L	L	L	L	L	L	L	L	L	L	H	L	"	"	"											
		49	L	L	L	H	L	L	L	L	L	L	L	H	L	"	"	"											
		50	L	H	L	L	L	L	L	L	L	L	L	H	L	"	"	"											
		51	L	H	L	L	L	L	L	L	L	L	L	H	L	5.0 V	5.0 V	"											
		52	L	H	L	L	L	L	L	L	L	L	L	H	L	5.0 V	5.0 V	"											
		53	L	L	L	H	L	L	L	L	L	L	L	H	L	GND	5.0 V	"											
		54	X	X	X	X	X	X	X	X	X	X	X	X	L	PC	"	"											
		55	H	L	L	L	L	L	L	L	L	L	L	L	L	5.0 V	"	"											
		56	H	L	L	L	L	L	L	L	L	L	L	L	L	GND	"	"											
		57	L	L	H	L	L	L	L	L	L	L	L	H	L	GND	5.0 V	"											
		58	L	L	H	L	L	L	L	L	L	L	L	H	L	GND	GND	"											
		59	L	H	L	L	L	L	L	L	L	L	L	H	L	5.0 V	"	"											
		60	X	X	X	X	X	X	X	X	X	X	X	X	L	PD	"	"											
		61	H	L	L	L	L	L	L	L	L	L	L	L	L	5.0 V	"	"											
		62	L	L	H	L	L	L	L	L	L	L	L	H	L	5.0 V	5.0 V	"											
		63	L	L	H	L	L	L	L	L	L	L	L	H	L	5.0 V	GND	"											
																						Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C		Subgroup 11 T _C = -55°C			
																				Min	Max	Min	Max	Min	Max				
t _{PHL1}	3003	64								GND				OUT	GND	IN	GND	5.0 V	CLOCK TO OUTPUT	.013	1.45	.018	2.18	.013	1.45	μs			
t _{PHL1} 1/2/		65	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	OUT	OUT	OUT	"	"	GND	"	CLOCK TO OUTPUT	"	1.80	"	2.70	"	1.80	"			
t _{PLH1}		66								"				OUT	"	"	GND	"	CLOCK TO OUTPUT	"	1.45	"	2.18	"	1.45	"			
t _{PLH1}		67	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	OUT	OUT	OUT	"	"	GND	"	CLOCK TO OUTPUT	"	1.80	"	2.70	"	1.80	"			
t _{PLH2}		68			OUT					"					"	"	IN	"	RESET TO OUTPUT	"	1.80	"	2.70	"	1.80	"			
t _{PLH2}		69								"				OUT	"	"	"	"	RESET TO OUTPUT	"	1.45	"	2.18	"	1.45	"			
t _{PHL2}		70	OUT	OUT		OUT	OUT	OUT	OUT	"	OUT	OUT	OUT		"	"	"	"	RESET TO OUTPUT	"	1.80	"	2.70	"	1.80	"			
t _{THL}	3004	71								"				OUT	"	"	GND	"	OUTPUT OUTPUT	10	550	14	825	10	550	ns			
t _{THL}		72	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	OUT	OUT	OUT	"	"	"	"	OUTPUT OUTPUT	.010	2.25	.014	3.38	.010	2.25	μs			
t _{TLH}	3004	73								"				OUT	"	"	"	"	OUTPUT OUTPUT	10	550	14	825	10	550	ns			
t _{TLH}		74	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	OUT	OUT	OUT	"	"	"	"	OUTPUT OUTPUT	.010	2.25	.014	3.38	.010	2.25	μs			
t _{SHL1} 2/		75								"				OUT	IN	"	"	"	CLOCK ENABLE TO CLOCK		500		750		500	ns			
t _{SHL1}		76	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	OUT	OUT		IN	"	"	"	CLOCK ENABLE TO CLOCK		750		1125		750	ns			
t _{SHL2}		77			OUT					"					GND	"	IN	"	RESET TO CLOCK		750		1125		750	ns			

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 02.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 4/																Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C		
			Test no.	DATA	JAM 1	JAM 2	Q2	Q1	Q3	JAM 3	V _{SS}	JAM 4	PRESET ENABLE	Q4	JAM 5	Q5	CLOCK	RESET		V _{DD}	Min	Max	Min	Max	Min	
V _{IC} (POS)			1	1mA	1mA	1mA					1mA		1mA	1mA		1mA	1mA	GND	EACH INPUT		1.5					V
V _{IC} (NEG)			2	-1mA	-1mA	-1mA					-1mA	GND	-1mA	-1mA		-1mA	-1mA		EACH INPUT		-6.0					V
I _{IL1} 6/	3009	3	GND	GND	GND						GND	GND	GND	GND		GND	GND	15.0V	ALL INPUTS TOGETHER		-900.0					nA
I _{IL2}	3009	4	GND	GND	GND						GND	"	GND	GND		GND	GND	"	EACH INPUT		-100.0		-100.0			"
I _{IH1}	3010	5	15.0V	15.0V	15.0V						15.0V	"	15.0V	15.0V		15.0V	15.0V	"	ALL INPUTS TOGETHER		900.0					"
I _{IH2}	3010	6	15.0V	15.0V	15.0V						15.0V	"	15.0V	15.0V		15.0V	15.0V	"	EACH INPUT		100.0		100.0			"
V _{OH1} 1/ 2/	3006	7	IN	GND	GND	I _{OH3}	I _{OH3}	I _{OH3}	GND	"	GND	GND	I _{OH3}	GND	I _{OH2}	IN	IN	5.0V	EACH OUTPUT	4.5		4.5		4.5		V
V _{OL1}	3007	8	"	"	"	I _{OL1}	I _{OL1}	I _{OL1}	"	"	"	"	I _{OL1}	"	I _{OL2}	"	"	5.0V	EACH OUTPUT		500		500		500	mV
V _{OH2}	3006	9	"	"	"	OUT	OUT	OUT	"	"	"	"	OUT	"	OUT	"	"	12.5V	EACH OUTPUT	11.25		11.25		11.25		V
V _{OL2}	3007	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	12.5V	EACH OUTPUT		1.25		1.25		1.25	"
V _{IL} 1/ 2/	Fig. 5	11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	5.0V	RESET	1.10		0.85		1.35		"
V _{IH}	Fig. 5	12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	RESET		3.80		3.60		3.95	"
V _{IL}	Fig. 7	13	"	IN	IN	"	"	"	IN	"	IN	IN	"	IN	"	"	"	"	PRESET ENABLE	1.10		0.85		1.35		"
V _{IH}	"	14	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	PRESET ENABLE		3.80		3.60		3.95	"
V _{IL}	"	15	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH JAM INPUT	1.10		0.85		1.35		"
V _{IH}	"	16	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH JAM INPUT		3.80		3.60		3.95	"
V _{IL}	Fig. 6	17	"	GND	GND	"	"	"	GND	"	GND	GND	"	GND	"	"	"	"	CLOCK	1.10		0.85		1.35		"
V _{IH}	Fig. 6	18	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	CLOCK		3.80		3.60		3.95	"
V _{IH}	Fig. 7	19	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	DATA		3.80		3.60		3.95	"
V _{IL}	Fig. 7	20	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	DATA	1.10		0.85		1.35		"
I _{SS} 3/	3005	21	GND	15.0V	15.0V				15.0V	"	15.0V	15.0V		15.0V		GND	15.0V	15.0V	V _{SS}		-0.5		-5.0			μA
		22	"	"	15.0V				GND	"	GND	"		"		GND	GND	"	V _{SS}		"		"			"
		23	"	"	GND				15.0V	"	"	"		"		GND	"	"	V _{SS}		"		"			"
		24	"	"	GND				15.0V	"	"	"		"		GND	"	"	None		"		"			"
		25	"	"	GND				15.0V	"	"	GND		"		15.0V	"	"	V _{SS}		"		"			"
		26	15.0V	GND	15.0V				GND	"	15.0V	15.0V		GND		GND	"	"	V _{SS}		"		"			"
		27	"	"	"				GND	"	"	15.0V		"		15.0V	"	"	None		"		"			"
		28	"	"	"				GND	"	"	GND		"		15.0V	"	"	V _{SS}		"		"			"
		29	"	"	"				15.0V	"	"	15.0V		"		15.0V	"	"	V _{SS}		"		"			"

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 02 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 4/																Measured terminal	Limits						Unit	
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C		Subgroup 11 T _C = -55°C			
			DATA	JAM 1	JAM 2	Q2	Q1	Q3	JAM 3	V _{SS}	JAM 4	PRESET ENABLE	Q4	JAM 5	Q5	CLOCK	RESET	V _{DD}		Min	Max	Min	Max	Min	Max		
t _{PHL1} 1/ 2/	3003	74	IN	GND	GND					GND	GND	GND	GND		GND	OUT	IN	GND	5.0V	CLOCK TO OUTPUT	.013	1.45	.018	2.18	.013	1.45	μs
t _{PLH1}	"	75	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	"	"	CLOCK TO OUTPUT	"	1.45	"	2.18	"	1.45	"
t _{PLH1}	"	77	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	"	"	CLOCK TO OUTPUT	"	1.80	"	2.70	"	1.80	"
t _{PLH2}	"	78	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	IN	"	RESET TO OUTPUT	"	1.45	"	2.18	"	1.45	"
t _{PLH2}	"	79	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	IN	"	RESET TO OUTPUT	"	1.80	"	2.70	"	1.80	"
t _{THL}	3004	80	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	GND	"	OUTPUTS	10	550	14	825	10	550	ns
t _{THL}	"	81	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	GND	"	OUTPUTS	.010	2.25	.014	3.38	.010	2.25	μs
t _{TLH1} 1/ 2/	3004	82	IN	GND	GND	OUT	OUT	OUT		GND	GND	GND	GND	OUT	"	OUT	"	GND	"	OUTPUTS	10	550	14	825	10	550	ns
t _{TLH1}	"	83	"	"	"	OUT	OUT	OUT		"	"	"	"	OUT	"	OUT	"	GND	"	OUTPUTS	.010	2.25	.014	3.38	.010	2.25	μs
t _{SHL1} 2/		84	"	"	"	"	"	"		"	"	"	"	IN	"	"	"	"	"	PRESET TO CLOCK		750		1125		750	ns
t _{SHL2}		85	"	"	"	"	"	"		"	"	"	"	GND	"	"	"	IN	"	RESET TO CLOCK		750		1125		750	"
t _{SHL3}		86	"	"	"	"	"	"		"	"	"	"	GND	"	"	"	GND	"	DATA TO CLOCK		500		750		500	"
t _{SLH3}		87	"	"	"	"	"	"		"	"	"	"	GND	"	"	"	GND	"	DATA TO CLOCK		500		750		500	"

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 03.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 4/																Measured terminal	Limits						Unit	
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C			
			Q12	Q13	Q14	Q6	Q5	Q7	Q4	V _{SS}	Q1	CLOCK	RESET	Q9	Q8	Q10	Q11	V _{DD}		Min	Max	Min	Max	Min	Max		
V _{IC} (POS)		1										1mA	1mA					GND	EACH INPUT		1.5					V	
V _{IC} (NEG)		2										GND	-1mA	-1mA					EACH INPUT		-6					V	
I _{IL1} 2/	3009	3										GND	GND					15.0V	ALL INPUTS TOGETHER		-200.0					nA	
I _{IL2}	3009	4										GND	GND						EACH INPUT		-100.0		-100.0			"	
I _{IH1}	3010	5										15.0V	15.0V						ALL INPUTS TOGETHER		200.0					"	
I _{IH2}	3010	6										15.0V	15.0V						EACH INPUT		100.0		100.0			"	
V _{OH1} 1/ 2/	3006	7	I _{OH4}	I _{OH4}	I _{OH4}	I _{OH4}	I _{OH4}	I _{OH4}	I _{OH4}	I _{OH4}	"	I _{OH4}	IN	IN	I _{OH4}	I _{OH4}	I _{OH4}	I _{OH4}	5.0V	EACH OUTPUT	4.5		4.5		4.5		V
V _{OL1}	3007	8	I _{OL3}	I _{OL3}	I _{OL3}	I _{OL3}	I _{OL3}	I _{OL3}	I _{OL3}	I _{OL3}	"	I _{OL3}	"	"	I _{OL3}	I _{OL3}	I _{OL3}	I _{OL3}	5.0V	EACH OUTPUT		500		500		500	mV
V _{OH2}	3006	9	OUT	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"	OUT	"	"	OUT	OUT	OUT	OUT	12.5V	EACH OUTPUT	11.25		11.25		11.25		V
V _{OL2}	3007	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	12.5V	EACH OUTPUT		1.25		1.25		1.25	"
V _{IL} 1/ 2/	Fig. 6	11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	5.0V	CLOCK	1.10		0.85		1.35		"
V _{IH}	Fig. 6	12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	CLOCK		3.80		3.60		3.95	"
V _{IL}	Fig. 5	13	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	RESET	1.10		0.85		1.35		"
V _{IH}	Fig. 5	14	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	RESET		3.80		3.60		3.95	"
I _{SS} 3/	3005	15										GND	15.0V					15.0V	V _{SS}		-1.0		-10.0			μA	
		16										GND	GND					"	V _{SS}		"		"			"	
		17										PU	"					"	None		"		"			"	
		18										GND	"					"	V _{SS}		"		"			"	
		19										PU	"					"	None		"		"			"	
		20										15.0V	"					"	V _{SS}		"		"			"	
																	Subgroup 4 T _C = 25°C										
																	Min	Max									
C _i 2/		21										GND	IN	IN				GND	EACH INPUT		12					pF	

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 03 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 4/																Measured terminal	Limits						Unit	
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 7		Subgroup 8					
			Test no.	Q12	Q13	Q14	Q6	Q5	Q7	Q4	V _{SS}	Q1	CLOCK	RESET	Q9	Q8	Q10	Q11		V _{DD}	T _C = 25°C		T _C = 125°C		T _C = -55°C		
																					Min	Max	Min	Max	Min		Max
Truth table test 3/	3014	22	L	L	L	L	L	L	L	GND	L	GND	5.0V	L	L	L	L	5.0V	EACH OUTPUT								
		23	L	L	L	L	L	L	L	"	L	GND	GND	L	L	L	L	"									
		24	L	L	L	L	L	L	L	"	L	5.0V	"	L	L	L	L	"									
		25	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		26	L	L	L	L	L	L	L	"	L	5.0V	"	L	L	L	L	"									
		27	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		28	X	X	X	X	X	X	X	"	X	PE	"	X	X	X	X	"									
		29	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		30	L	L	L	L	L	L	L	"	H	GND	"	L	L	L	L	"									
		31	X	X	X	X	X	X	X	"	X	PF	"	X	X	X	X	"									
		32	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		33	L	L	L	L	H	L	L	"	L	GND	"	L	L	L	L	"									
		34	X	X	X	X	X	X	X	"	X	PG	"	X	X	X	X	"									
		35	L	L	L	L	H	L	H	"	H	5.0V	"	L	L	L	L	"									
		36	L	L	L	L	H	L	L	"	L	GND	"	L	L	L	L	"									
		37	X	X	X	X	X	X	X	"	X	PH	"	X	X	X	X	"									
		38	L	L	L	L	H	H	L	"	H	5.0V	"	L	L	L	L	"									
		39	L	L	L	L	L	L	H	"	L	GND	"	L	L	L	L	"									
		40	X	X	X	X	X	X	X	"	X	PJ	"	X	X	X	X	"									
		41	L	L	L	L	H	H	H	"	H	5.0V	"	L	L	L	L	"									
		42	X	X	X	X	L	L	L	"	L	GND	"	L	H	L	L	"									
		43	X	X	X	X	X	X	X	"	X	PL	"	X	X	X	X	"									
		44	L	L	L	L	H	H	H	"	H	5.0V	"	L	H	L	L	"									
		45	L	L	L	L	L	L	L	"	L	GND	"	H	L	L	L	"									
		46	X	X	X	X	X	X	X	"	X	PM	"	X	X	X	X	"									
		47	L	L	L	L	H	H	H	"	H	5.0V	"	H	H	L	L	"									
		48	L	L	L	L	L	L	L	"	L	GND	"	L	L	H	L	"									
		49	X	X	X	X	X	X	X	"	X	PN	"	X	X	X	X	"									
		50	L	L	L	L	H	H	H	"	H	5.0V	"	H	H	H	H	"									
		51	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	H	"									
		52	X	X	X	X	X	X	X	"	X	PR	"	X	X	X	X	"									
		53	L	L	L	L	H	H	H	"	H	5.0V	"	H	H	H	H	"									
		54	H	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		55	X	X	X	X	X	X	X	"	X	PS	"	X	X	X	X	"									
		56	H	L	L	L	H	H	H	"	H	5.0V	"	H	H	H	H	"									
		57	L	H	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		58	X	X	X	X	X	X	X	"	X	PT	"	X	X	X	X	"									
		59	H	H	L	L	H	H	H	"	H	5.0V	"	H	H	H	H	"									
		60	L	L	H	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		61	X	X	X	X	X	X	X	"	X	PV	"	X	X	X	X	"									
		62	H	H	H	H	H	H	H	"	H	5.0V	"	H	H	H	H	"									
		63	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		64	X	X	X	X	X	X	X	"	X	PY	"	X	X	X	X	"									
		65	H	L	L	H	H	L	L	"	L	GND	"	L	H	H	L	"									
		66	L	L	L	L	L	L	L	"	L	GND	5.0V	L	L	L	L	"									
		67	L	L	L	L	L	L	L	"	L	GND	GND	L	L	L	L	"									
		68	X	X	X	X	X	X	X	"	X	PU	"	X	X	X	X	"									
		69	L	L	L	L	H	H	L	"	H	GND	GND	H	L	L	H	"									
		70	L	L	L	L	L	L	L	"	L	GND	5.0V	L	L	L	L	"									
		71	L	L	L	L	L	L	L	"	L	GND	GND	L	L	L	L	"									

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 03 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 4/														Measured terminal	Limits						Unit		
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		15	16	Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C			Subgroup 11 T _C = -55°C	
			Q12	Q13	Q14	Q6	Q5	Q7	Q4	V _{SS}	Q1	CLOCK	RESET	Q9	Q8	Q10		Q11	V _{DD}	Min	Max	Min	Max		Min	Max
t _{PHL1 1/ 2/}	3003	72																5.0V	CLOCK TO OUTPUT	.013	0.89	.018	1.34	.013	0.89	μs
	"	73																"	"	.052	3.50	.072	5.25	.052	3.50	"
	"	74																"	"	.065	4.45	.090	6.68	.065	4.45	"
	"	75																"	"	.078	5.35	.108	8.03	.078	5.35	"
	"	76																"	"	.091	6.20	.126	9.30	.091	6.20	"
	"	77																"	"	.104	7.10	.144	10.65	.104	7.10	"
	"	78																"	"	.117	8.10	.162	12.15	.117	8.10	"
	"	79																"	"	.130	8.90	.180	13.35	.130	8.90	"
	"	80																"	"	.143	9.90	.198	14.85	.143	9.90	"
	"	81	OUT															"	"	.156	10.70	.216	16.05	.156	10.70	"
	"	82		OUT														"	"	.169	11.60	.234	17.40	.169	11.60	"
	"	83			OUT													"	"	.182	12.50	.252	18.75	.182	12.50	"
t _{PLH1}	"	84																"	"	.013	0.89	.018	1.34	.013	0.89	"
	"	85																"	"	.052	3.50	.072	5.25	.052	3.50	"
	"	86																"	"	.065	4.45	.090	6.68	.065	4.45	"
	"	87																"	"	.078	5.35	.108	8.03	.078	5.35	"
	"	88																"	"	.091	6.20	.126	9.30	.091	6.20	"
	"	89																"	"	.104	7.10	.144	10.65	.104	7.10	"
	"	90																"	"	.117	8.10	.162	12.15	.117	8.10	"
	"	91																"	"	.130	8.90	.180	13.35	.130	8.90	"
	"	92																"	"	.143	9.90	.198	14.85	.143	9.90	"
	"	93	OUT															"	"	.156	10.70	.216	16.05	.156	10.70	"
	"	94		OUT														"	"	.169	11.60	.234	17.40	.169	11.60	"
	"	95			OUT													"	"	.182	12.50	.252	18.75	.182	12.50	"
t _{PHL2}	"	96	OUT	OUT	"	OUT	OUT	OUT	OUT	"	OUT	"	IN	OUT	OUT	OUT	OUT	"	RESET TO OUTPUT	.013	3.30	.018	4.95	.013	3.30	"
t _{THL}	3004	97	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	"	OUTPUT	.010	1.15	.014	1.73	.010	1.15	"
t _{TLH}	3004	98	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	"	OUTPUT	.010	1.15	.014	1.73	.010	1.15	"

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 04.

Symbol	MIL-STD-883 method	Cases E,F,N,Z Test no.	Terminal conditions 4/														Measured terminal	Limits						Unit				
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		15	16	Subgroup 1 T _c = 25°C		Subgroup 2 T _c = 125°C			Subgroup 3 T _c = -55°C			
			1 OUT	0 OUT	2 OUT	5 OUT	6 OUT	NC	3 OUT	V _{SS}	NC	7 OUT	4 OUT	CARRY OUT	CLOCK ENABLE	CLOCK		RESET	V _{DD}	Min	Max	Min	Max		Min	Max		
V _{IC} (POS)		1												1 mA	1 mA	1 mA	GND	EACH INPUT		1.5					V			
V _{IC} (NEG)		2												GND	-1 mA	-1 mA	-1 mA		EACH INPUT		-6.0					V		
I _{IL1} 6/	3009	3															GND	GND	GND	15.0V	ALL INPUTS TOGETHER		-300					nA
I _{IL2}	3009	4															GND	GND	GND		EACH INPUT		-100		-100			"
I _{IH1}	3010	5															15.0V	15.0V	15.0V		ALL INPUTS TOGETHER		300					"
I _{IH2}	3010	6															15.0V	15.0V	15.0V		EACH INPUT		100		100			"
V _{OH1} 1/ 2/	3006	7	I _{OH5}	I _{OH5}	I _{OH5}	I _{OH5}	I _{OH5}			I _{OH5}			I _{OH5}	I _{OH5}	I _{OH2}	GND	IN	IN	5.0V	EACH INPUT	4.5		4.5		4.5		V	
V _{OL1}	3007	8	I _{OL4}	I _{OL4}	I _{OL4}	I _{OL4}	I _{OL4}			I _{OL4}			I _{OL4}	I _{OL4}	I _{OL2}				5.0V	EACH OUTPUT		500		500		500	mV	
V _{OH2}	3006	9	OUT	OUT	OUT	OUT	OUT			OUT			OUT	OUT	OUT				12.5V	EACH OUTPUT	11.25		11.25		11.25		V	
V _{OL2}	3007	10	"	"	"	"	"			"	"		"	"	"				12.5V	EACH OUTPUT		1.25		1.25		1.25	"	
V _{IL} 1/ 2/	Fig. 6	11	"	"	"	"	"			"	"		"	"	"				5.0V	CLOCK ENABLE	1.10		0.85		1.35		"	
V _{IH}	"	12	"	"	"	"	"			"	"		"	"	"				IN	CLOCK ENABLE		3.80		3.60		3.95	"	
V _{IL}	"	13	"	"	"	"	"			"	"		"	"	"				GND	CLOCK	1.10		0.85		1.35		"	
V _{IH}	"	14	"	"	"	"	"			"	"		"	"	"				"	CLOCK		3.80		3.60		3.95	"	
V _{IL}	Fig. 5	15	"	"	"	"	"			"	"		"	"	"				"	RESET	1.10		0.85		1.35		"	
V _{IH}	"	16	"	"	"	"	"			"	"		"	"	"				"	RESET		3.80		3.60		3.95	"	
I _{SS} 3/	3005	17																	15.0V	15.0V	V _{SS}		-0.5		-5.0			μA
"	"	18																	GND	GND	V _{SS}		"		"			"
"	"	19																	15.0V	GND	V _{SS}		"		"			"
"	"	20																	GND	GND	None		"		"			"
"	"	21																	15.0V	GND	V _{SS}		"		"			"
"	"	22																	GND	GND	V _{SS}		"		"			"
"	"	23																	15.0V	GND	V _{SS}		"		"			"
"	"	24																	GND	GND	V _{SS}		"		"			"
"	"	25																	15.0V	GND	V _{SS}		"		"			"
"	"	26																	GND	GND	None		"		"			"
"	"	27																	15.0V	GND	V _{SS}		"		"			"
"	"	28																	GND	GND	None		"		"			"
"	"	29																	15.0V	GND	V _{SS}		"		"			"
"	"	30																	GND	GND	None		"		"			"
"	"	31																	15.0V	GND	V _{SS}		"		"			"
"	"	32																	15.0V	15.0V	V _{SS}		"		"			"

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 04 – Continued.

Symbol	MIL-STD-883 method	Cases E,F,N,Z Test no.	Terminal conditions 4/																Measured terminal	Limits						Unit													
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 4 T _C = 25°C		Limits																	
			1 OUT	0 OUT	2 OUT	5 OUT	6 OUT	NC	3 OUT	V _{SS}	NC	7 OUT	4 OUT	CARRY OUT	CLOCK ENABLE	CLOCK	RESET	V _{DD}		Min	Max	Min	Max	Min	Max														
C ₂ /	3012	33								GND											EACH INPUT		12					pF											
																				Subgroup 7 T _C = 25°C		Subgroup 8 T _C = 125°C				Subgroup 8 T _C = -55°C													
																				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
Truth table test 3/	3014	34	L	H	L	L	L	L	L	GND			L	L	H	GND	5.0V	5.0V	5.0V		EACH OUTPUT																		
"	"	35	L	H	L	L	L	L	L	"			L	L	H	"	5.0V	GND	"		"																		
"	"	36	H	L	L	L	L	L	L	"			L	L	H	"	PA	"	"		"																		
"	"	37	L	L	H	L	L	L	L	"			L	L	H	"	"	"	"		"																		
"	"	38	L	L	L	L	L	L	L	H			L	L	H	"	"	"	"		"																		
"	"	39	L	L	L	L	L	L	L	"			L	L	H	"	"	"	"		"																		
"	"	40	L	L	L	H	L	L	L	"			L	L	L	"	"	"	"		"																		
"	"	41	L	L	L	L	L	L	H	"			L	L	L	"	"	"	"		"																		
"	"	42	L	L	L	L	L	L	L	"			L	L	L	"	"	"	"		"																		
"	"	43	L	H	L	L	L	L	L	"			H	L	L	"	"	"	"		"																		
"	"	44	L	H	L	L	L	L	L	"			L	L	L	"	"	"	"		"																		
"	"	45	H	L	L	L	L	L	L	"			L	L	L	"	"	"	"		"																		
"	"	46	H	L	L	L	L	L	L	"			L	L	L	5.0V	5.0V	"	"		"																		
"	"	47	H	L	L	L	L	L	L	"			L	L	L	GND	GND	"	"		"																		
"	"	48	H	L	L	L	L	L	L	"			L	L	L	5.0V	5.0V	"	"		"																		
"	"	49	X	X	X	X	X	X	X	"			X	X	X	GND	PB	"	"		"																		
"	"	50	L	L	L	L	L	L	L	"			L	L	H	"	5.0V	"	"		"																		
"	"	51	L	L	L	L	L	L	L	"			L	L	H	"	GND	"	"		"																		
"	"	52	L	L	H	L	L	L	L	"			L	L	L	"	GND	5.0V	"		"																		
"	"	53	L	L	H	L	L	L	L	"			L	L	L	"	GND	GND	"		"																		
"	"	54	H	L	L	L	L	L	L	"			L	L	L	"	5.0V	"	"		"																		
"	"	55	X	X	X	X	X	X	X	"			X	X	X	"	PC	"	"		"																		
"	"	56	L	L	L	L	L	L	L	"			L	L	H	"	5.0V	"	"		"																		
"	"	57	L	L	L	L	L	L	L	"			L	L	L	"	5.0V	5.0V	"		"																		
"	"	58	L	L	L	L	L	L	L	"			L	L	L	"	5.0V	GND	"		"																		
																				Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C				Subgroup 11 T _C = -55°C													
																				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
t _{PHL1} 1/ 2/	3003	59	OUT	OUT	OUT	OUT	OUT	OUT	OUT	GND			OUT	OUT	OUT	GND	IN	GND	5.0V		CLOCK TO OUTPUT	.013	1.20	.018	1.80	.013	1.20	μs											
t _{PHL1}	"	60								"			OUT	OUT	OUT	"	"	"	"		CLOCK TO OUTPUT	"	2.25	"	3.38	"	2.25	"											
t _{PLH1}	"	61	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		CLOCK TO OUTPUT	"	1.20	"	1.80	"	1.20	"											
t _{PLH1}	"	62								"			OUT	OUT	OUT	"	"	"	"		RESET TO OUTPUT	"	2.25	"	3.38	"	2.25	"											
t _{PLH2}	"	63	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		RESET TO OUTPUT	"	2.25	"	3.38	"	2.25	"											
t _{PLH2}	"	64								"			OUT	OUT	OUT	"	"	"	"		RESET TO OUTPUT	"	1.20	"	1.80	"	1.20	"											
t _{PHL2}	"	65	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		RESET TO OUTPUT	"	2.25	"	3.38	"	2.25	"											
t _{THL}	3004	66	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		OUTPUT OUTPUT	10	500	14	750	10	500	ns											
t _{THL}	"	67								"			OUT	OUT	OUT	"	"	"	"		OUTPUT OUTPUT	"	500	"	750	"	500	ns											
t _{TLH}	"	68	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		OUTPUT OUTPUT	"	600	"	900	"	600	ns											
t _{TLH}	"	69								"			OUT	OUT	OUT	"	"	"	"		OUTPUT OUTPUT	"	600	"	900	"	600	ns											
t _{SHL1} 2/	"	70	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		CLOCK ENABLE TO CLOCK	"	500	"	750	"	500	ns											
t _{SHL1}	"	71								"			OUT	OUT	OUT	"	"	"	"		CLOCK TO CLOCK	"	750	"	1125	"	750	ns											
t _{SHL1}	"	72	OUT	OUT	OUT	OUT	OUT	OUT	OUT	"			OUT	OUT	OUT	"	"	"	"		CLOCK ENABLE TO CLOCK	"	750	"	1125	"	750	ns											
t _{SHL2}	"	72								"			OUT	OUT	OUT	"	"	"	"		RESET TO CLOCK	"	750	"	1125	"	750	ns											

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 05.

Symbol	MIL-STD-883 method	Cases A,B,C,D T,X,Y	Terminal conditions 4/														Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C		
			Test no.	CLOCK	RESET	Q7	Q6	Q5	Q4	V _{SS}	NC	Q3	NC	Q2	Q1	NC		V _{DD}	Min	Max	Min	Max	Min	
V _{IC} (POS)		1	1 mA	1 mA											GND	EACH INPUT	1.5						V	
V _{IC} (NEG)		2	-1 mA	-1 mA						GND						EACH INPUT	-6.0						V	
I _{IL} 6/	3009	3	GND	GND						"					15.0V	CLOCK	-100.0		-100.0			nA		
I _{IL}	3009	4	GND	GND						"					"	RESET	-100.0		-100.0			"		
I _{IH}	3010	5	15.0V	GND						"					"	CLOCK	100.0		100.0			"		
I _{IH}	3010	6	GND	15.0V						"					"	RESET	100.0		100.0			"		
V _{OH1} 2/	3006	7	IN	IN	I _{OH2}	I _{OH2}	I _{OH2}	I _{OH2}	"		I _{OH2}		I _{OH2}	I _{OH2}	5.0V	EACH OUTPUT	4.5		4.5		4.5	V		
V _{OL1}	3007	8	"	"	I _{OL5}	I _{OL5}	I _{OL5}	I _{OL5}	"		I _{OL5}		I _{OL5}	I _{OL5}	5.0V	EACH OUTPUT	500		500		500	mV		
V _{OH2}	3006	9	"	"	OUT	OUT	OUT	OUT	"		OUT		OUT	OUT	12.5V	EACH OUTPUT	11.25		11.25		11.25	V		
V _{OL2}	3007	10	"	"	"	"	"	"	"		"		"	"	12.5V	EACH OUTPUT	1.25		1.25		1.25	"		
V _{IL} 1/ 2/	Fig. 6	11	"	"	"	"	"	"	"		"		"	"	5.0V	CLOCK	1.10		0.85		1.35	"		
V _{IH}	Fig. 6	12	"	"	"	"	"	"	"		"		"	"	"	CLOCK	3.80		3.60		3.95	"		
V _{IL}	Fig. 5	13	"	"	"	"	"	"	"		"		"	"	"	RESET	1.10		0.85		1.35	"		
V _{IH}	Fig. 5	14	"	"	"	"	"	"	"		"		"	"	"	RESET	3.80		3.60		3.95	"		
I _{SS} 3/	3005	15	GND	15.0V					"		"				15.0V	V _{SS}	-0.5		-5.0			μA		
"	"	16	GND	GND					"		"				"	V _{SS}	"		"			"		
"	"	17	PI	"					"		"				"	None	"		"			"		
"	"	18	15.0V	"					"		"				"	V _{SS}	"		"			"		
"	"	19	GND	"					"		"				"	None	"		"			"		
"	"	20	PI	"					"		"				"	None	"		"			"		
"	"	21	GND	"					"		"				"	V _{SS}	"		"			"		
																	Subgroup 4 T _C = 25°C							
																	Min	Max						
C _i 2/	3012	22	IN	IN					GND						GND	EACH INPUT		12					pF	

See footnotes at end of device type 05.

TABLE III. Group A inspection for device type 05 – Continued.

Symbol	MIL-STD-883 method	Cases A,B,C,D T,X,Y	Terminal conditions 4/														Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		Subgroup 7 T _C = 25°C		Subgroup 8				
			CLOCK	RESET	Q7	Q6	Q5	Q4	V _{SS}	NC	Q3	NC	Q2	Q1	NC	V _{DD}		Min	Max	T _C = 125°C		T _C = -55°C		
Truth table test 3/	3014	23	GND	5.0V	L	L	L	L	L	GND		L	L	L	L	5.0V	Each output							
"	"	24	GND	GND	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	25	5.0V	"	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	26	GND	"	L	L	L	L	L	"		L	L	H	L	"	"							
"	"	27	5.0V	"	L	L	L	L	L	"		L	L	H	L	"	"							
"	"	28	GND	"	L	L	L	L	L	"		L	H	L	L	"	"							
"	"	29	5.0V	"	L	L	L	L	L	"		L	H	L	L	"	"							
"	"	30	GND	"	L	L	L	L	L	"		L	H	H	L	"	"							
"	"	31	5.0V	"	L	L	L	L	L	"		L	H	H	L	"	"							
"	"	32	GND	"	L	L	L	L	L	"		H	L	L	L	"	"							
"	"	33	PC	"	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	34	5.0V	"	L	L	L	L	L	"		H	H	H	L	"	"							
"	"	35	GND	"	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	36	PF	"	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	37	5.0V	"	L	L	L	L	L	"		H	H	H	L	"	"							
"	"	38	GND	"	L	L	L	H	L	"		L	L	L	L	"	"							
"	"	39	PG	"	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	40	5.0V	"	L	L	L	H	H	"		H	H	H	L	"	"							
"	"	41	GND	"	L	L	H	L	L	"		L	L	L	L	"	"							
"	"	42	PH	"	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	43	5.0V	"	L	H	H	H	H	"		H	H	H	L	"	"							
"	"	44	GND	"	H	L	L	L	L	"		L	L	L	L	"	"							
"	"	45	PJ	"	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	46	5.0V	"	H	H	H	H	H	"		H	H	H	L	"	"							
"	"	47	GND	"	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	48	PI	"	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	49	GND	"	L	H	L	L	L	"		L	L	L	L	"	"							
"	"	50	GND	5.0V	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	51	GND	GND	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	52	PK	GND	X	X	X	X	X	"		X	X	X	X	"	"							
"	"	53	GND	GND	H	L	L	H	L	"		H	L	L	L	"	"							
"	"	54	GND	5.0V	L	L	L	L	L	"		L	L	L	L	"	"							
"	"	55	GND	GND	L	L	L	L	L	"		L	L	L	L	"	"							
																	Subgroup 9 T _C = 25°C	Subgroup 10 T _C = 125°C	Subgroup 11 T _C = -55°C					
t _{PHL1} 1/2/	3003	56	IN	GND					GND				OUT	OUT		5.0V	CLOCK TO OUTPUT	.013	0.44	.018	0.66	.013	0.44	μs
"	"	57	"	"					"				OUT	OUT		"	"	.026	0.88	.036	1.32	.026	0.88	"
"	"	58	"	"					"				OUT	OUT		"	"	.039	1.32	.054	1.98	.039	1.32	"
"	"	59	"	"					"				OUT	OUT		"	"	.052	1.76	.072	2.64	.052	1.76	"
"	"	60	"	"				OUT	"				OUT	OUT		"	"	.065	2.20	.090	3.30	.065	2.20	"
"	"	61	"	"				OUT	"				OUT	OUT		"	"	.078	2.64	.108	3.96	.078	2.64	"
"	"	62	"	"	OUT	OUT	OUT	OUT	"				OUT	OUT		"	"	.091	3.10	.126	4.65	.091	3.10	"
t _{PLH1}	"	63	"	"					"				OUT	OUT		"	"	.013	0.44	.018	0.66	.013	0.44	"
"	"	64	"	"					"				OUT	OUT		"	"	.026	0.88	.036	1.32	.026	0.88	"
"	"	65	"	"					"				OUT	OUT		"	"	.039	1.32	.054	1.98	.039	1.32	"
"	"	66	"	"					"				OUT	OUT		"	"	.052	1.76	.072	2.64	.052	1.76	"
"	"	67	"	"					"				OUT	OUT		"	"	.065	2.20	.090	3.30	.065	2.20	"
"	"	68	"	"				OUT	"				OUT	OUT		"	"	.078	2.64	.108	3.96	.078	2.64	"
"	"	69	"	"	OUT	OUT	OUT	OUT	"				OUT	OUT		"	"	.091	3.10	.126	4.65	.091	3.10	"
t _{PHL2}	"	70	"	IN	OUT	OUT	OUT	OUT	"				OUT	OUT		"	RESET TO OUTPUT	.013	1.50	.018	2.25	.013	1.50	μs
t _{THL}	3004	71	"	GND	"	"	"	"	"				"	"		"	OUTPUT	10	430	14	645	10	430	ns
t _{TLH}	3004	72	"	GND	"	"	"	"	"				"	"		"	OUTPUT	10	700	14	1050	10	700	ns

See footnotes on next page.

- 1/ Unless otherwise specified, separately monitor or measure as required, each device terminal designated "OUT", "I_{OH}", and "I_{OL}" in the terminal condition columns of table III. Values for "I_{OH}" and "I_{OL}" are specified in footnote 5.
- 2/ Terminals designated "IN" indicate conditions and test methods are specified in footnote 5 and figures 4 through 8 or for "C_i" measurement, see 4.4.1c.
- 3/ This I_{SS} and functional tests shall be performed in the test number sequence shown with no intervening changes to terminal conditions. The functional test shall be performed with V_{IH} and V_{DD} ≤ 5.0 V and ≥ 15.0 V. Table III shows the lower of these two voltages. During the functional test, input terminals designated "PA", "PB", etc., shall have applied thereto a specified number of single pulses with the following parameters: Pulse amplitude = V_{DD} maximum to V_{DD} = 4% minimum. These pulses are enumerated as follows:

Symbol	Pulses	Symbol	Pulses	Symbol	Pulses	Symbol	Pulses
PA	1	PF	7	PK	85	PS	2047
PB	2	PG	15	PL	127	PT	4095
PC	3	PH	31	PM	255	PU	5461
PD	4	PI	42	PN	511	PV	8191
PE	5	PJ	63	PR	1023	PY	10922

During the functional tests, device output voltages are: don't care "X", high "H", or low "L" as specified in the terminal conditions columns. The output voltage limits over the specified temperature range are "H" = V_{DD} -0.50 V minimum and "L" = V_{SS} +0.50 V maximum.

- 4/ Undesignated terminal conditions indicate terminal may be high-level logic, low-level logic, or open except as follows: V_{IC(POS)} tests, the V_{SS} terminals shall be open; V_{IC(NEG)} tests, the V_{DD} terminals shall be open; I_{SS} tests, the output terminals shall be open.
- 5/ The following input voltages and output currents are terminal conditions for group A inspection:

Temperature	Symbol													
	V _{IH1} Max (V)	V _{IL1} Min (V)	V _{IH2} Max (V)	V _{IL2} Min (V)	I _{OH1} (μA)	I _{OH2} (μA)	I _{OH3} (μA)	I _{OH4} (μA)	I _{OH5} (μA)	I _{OL1} (μA)	I _{OL2} (μA)	I _{OL3} (μA)	I _{OL4} (μA)	I _{OL5} (μA)
25°C	3.80	1.10	9.50	2.80	-30	-150	-60	-90	-30	50	150	100	50	250
125°C	3.60	0.85	9.25	2.55	-21	-105	-40	-65	-21	35	105	90	35	175
-55°C	3.95	1.35	9.75	3.05	-38.0	-185	-75	-110	-38	60	185	125	60	310

- 6/ The device manufacturer may, at his option, measure I_{IL} and I_{IH} at 25°C for each individual input or measure all inputs together.
- 7/ Data pin need only be toggled high or low to allow outputs to achieve the proper setup state required to verify the indicated test parameter.

TABLE III. Group A inspection for device type 51.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 1/																Measured terminal	Limits						Unit			
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C					
			5 OUT	1 OUT	0 OUT	2 OUT	6 OUT	7 OUT	3 OUT	V _{SS}	8 OUT	4 OUT	9 OUT	CARRY OUT	CLOCK ENABLE	CLOCK	RESET	V _{DD}		Min	Max	Min	Max	Min	Max				
V _{IC} (POS)		1															1 mA	1 mA	1 mA	GND	EACH INPUT		1.5						V
V _{IC} (NEG)		2															-1 mA	-1 mA	-1 mA		EACH INPUT		-6.0						V
I _{IL1} 2/	3009	3															GND	GND	GND	18.0 V	ALL INPUTS TOGETHER		-300.0						nA
I _{IL2}	3009	4															GND	GND	GND	"	EACH INPUT		-100.0		-100.0				"
I _{IH1}	3010	5															18.0 V	18.0 V	18.0 V	"	ALL INPUTS TOGETHER		300.0						"
I _{IH2}	3010	6															18.0 V	18.0 V	18.0 V	"	EACH INPUT		100.0		100.0				"
I _{OL}		7	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	EACH INPUT	4/	4/	4/	4/	4/	4/	4/	mA
I _{OH}		8	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	mA
V _{OL}	3007	9	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V
V _{OH}	3006	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
V _{IL}		11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"	"
V _{IH}		12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"	"
I _{SS} 5/	3005	13															GND	GND	18.0 V	18.0V	V _{SS}		-0.5		-5.0				μA
"	"	14															"	GND	GND	"	V _{SS}		"		"				"
"	"	15															"	18.0V	"	"	None		"		"				"
"	"	16															"	GND	"	"	V _{SS}		"		"				"
"	"	17															"	18.0V	"	"	None		"		"				"
"	"	18															"	GND	"	"	V _{SS}		"		"				"
"	"	19															"	18.0V	"	"	None		"		"				"
"	"	20															"	GND	"	"	V _{SS}		"		"				"
"	"	21															"	18.0V	"	"	None		"		"				"
"	"	22															"	GND	"	"	V _{SS}		"		"				"
"	"	23															"	18.0V	"	"	V _{SS}		"		"				"
"	"	24															"	GND	"	"	None		"		"				"
"	"	25															"	18.0V	"	"	V _{SS}		"		"				"
"	"	26															"	GND	"	"	None		"		"				"
"	"	27															"	18.0V	"	"	V _{SS}		"		"				"
"	"	28															"	GND	"	"	None		"		"				"
"	"	29															"	18.0V	"	"	V _{SS}		"		"				"
"	"	30															"	GND	"	"	None		"		"				"
"	"	31															"	18.0V	"	"	V _{SS}		"		"				"
"	"	32															18.0V	18.0V	"	"	V _{SS}		"		"				"

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 52.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 1/																Measured terminal	Limits						Unit		
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C				
			DATA	JAM 1	JAM 2	Q2	Q1	Q3	JAM 3	V _{SS}	JAM 4	PRESET ENABLE	Q4	JAM 5	Q5	CLOCK	RESET	V _{DD}		Min	Max	Min	Max	Min	Max			
V _{IC} (POS)		1	1mA	1mA	1mA						1mA		1mA	1mA		1mA	1mA	GND	EACH INPUT		1.5						V	
V _{IC} (NEG)		2	-1mA	-1mA	-1mA						-1mA	GND	-1mA	-1mA		-1mA	-1mA		EACH INPUT		-6.0						V	
I _{IL1 2/}	3009	3	GND	GND	GND						GND	"	GND	GND		GND	GND	18.0V	ALL INPUTS TOGETHER		-900.0						nA	
I _{IL2}	3009	4	GND	GND	GND						GND	"	GND	GND		GND	"	18.0V	EACH INPUT		-100.0		-100.0				"	
I _{IH1}	3010	5	18.0V	18.0V	18.0V						18.0V	"	18.0V	18.0V		18.0V	18.0V	"	ALL INPUTS TOGETHER		900.0						"	
I _{IH2}	3010	6	18.0V	18.0V	18.0V						18.0V	"	18.0V	18.0V		18.0V	18.0V	"	EACH INPUT		100.0		100.0				"	
I _{OL}		7	4/	4/	4/	4/	4/	4/	4/	4/	"	4/	4/	4/	4/	4/	4/	4/	EACH OUTPUT	4/	4/	4/	4/	4/	4/	4/	mA	
I _{OH}		8	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
V _{OL}	3007	9	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V	
V _{OH}	3006	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
V _{IL}		11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"	"	
V _{IH}		12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"	"	
I _{SS 5/}	3005	13	GND	18.0V	18.0V						18.0V	"	18.0V	18.0V		18.0V	"	GND	18.0V	18.0V	V _{SS}		-0.5		-5.0			μA
	"	14	"	"	18.0V						GND	"	GND	"		"	"	GND	GND	GND	V _{SS}		"		"		"	"
	"	15	"	"	GND						18.0V	"	"	"		"	"	GND	GND	GND	V _{SS}		"		"		"	"
	"	16	"	"	GND						18.0V	"	"	"		"	"	18.0V	18.0V	None	V _{SS}		"		"		"	"
	"	17	"	"	GND						18.0V	"	"	GND		"	"	18.0V	"	"	V _{SS}		"		"		"	"
	"	18	18.0V	GND	18.0V						GND	"	18.0V	18.0V		GND	"	GND	"	"	V _{SS}		"		"		"	"
	"	19	"	"	"						GND	"	"	18.0V		"	"	18.0V	"	None	V _{SS}		"		"		"	"
	"	20	"	"	"						GND	"	"	GND		"	"	18.0V	"	"	V _{SS}		"		"		"	"
	"	21	"	"	"						18.0V	"	"	18.0V		"	"	18.0V	"	V _{SS}	V _{SS}		"		"		"	"

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 52 – Continued.

Symbol	MIL-STD-883 method	Cases E,F,N,Z	Terminal conditions 1/																Measured terminal	Limits						Unit						
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 4 T _C = 25°C												
			Test no.	DATA	JAM 1	JAM 2	Q2	Q1	Q3	JAM 3	V _{SS}	JAM 4	PRESET ENABLE	Q4	JAM 5	Q5	CLOCK	RESET		V _{DD}	Min	Max	Min	Max	Min		Max					
C _i 3/	3012	22	IN	IN	IN					IN	GND	IN	IN		IN		IN	IN	GND	EACH INPUT		12.0						pF				
																			Subgroup 7 T _C = 25°C		Subgroup 8											
																			Min	Max	Min	Max	Min	Max	Min	Max						
Truth table test 5/	3014	23	5.0V	5.0V	5.0V	L	L	L	5.0V	GND	5.0V	5.0V	L	5.0V	L	5.0V	GND	5.0V	EACH OUTPUT													
		24	5.0V	5.0V	5.0V	H	H	H	5.0V	"	5.0V	5.0V	H	5.0V	H	"	5.0V	"														
		25	5.0V	GND	GND	H	H	H	GND	"	GND	GND	H	GND	H	"	5.0V	"														
		26	GND	GND	"	H	H	H	GND	"	"	GND	H	GND	H	"	GND	"														
		27	5.0V	5.0V	"	H	H	H	5.0V	"	"	GND	H	5.0V	H	"	"	"														
		28	"	5.0V	"	H	L	L	5.0V	"	"	5.0V	H	5.0V	L	"	"	"														
		29	"	5.0V	"	H	L	L	5.0V	"	"	GND	H	5.0V	L	"	"	"														
		30	"	GND	"	H	L	L	GND	"	"	"	H	GND	L	"	"	"														
		31	"	"	"	L	L	H	"	"	"	"	L	"	L	GND	"	"														
		32	GND	"	"	L	L	H	"	"	"	"	L	"	H	5.0V	"	"														
		33	GND	"	"	L	L	H	"	"	"	"	L	"	H	GND	"	"														
		34	GND	"	"	L	L	H	"	"	"	"	L	"	L	5.0V	"	"														
		35	5.0V	"	"	L	H	L	"	"	"	"	H	"	L	5.0V	"	"														
		36	"	"	"	L	H	L	"	"	"	"	H	"	L	GND	"	"														
		37	"	"	"	H	L	L	"	"	"	"	L	"	H	5.0V	"	"														
		38	"	"	"	H	H	H	"	"	"	"	H	"	H	5.0V	5.0V	"														
		39	"	"	"	H	H	H	"	"	"	"	H	"	H	5.0V	GND	"														
		40	"	5.0V	5.0V	H	H	H	"	"	5.0V	"	H	"	H	GND	"	"														
		41	"	5.0V	5.0V	L	L	H	"	"	5.0V	5.0V	L	"	H	"	"	"														
		42	"	5.0V	5.0V	L	L	H	"	"	5.0V	GND	L	"	H	"	"	"														
		43	"	GND	GND	L	L	H	5.0V	"	GND	GND	L	5.0V	H	"	"	"														
		44	"	"	"	H	H	L	"	"	"	5.0V	H	"	L	"	"	"														
		45	"	"	"	H	H	L	"	"	"	GND	H	"	L	"	"	"														
		46	"	"	"	H	H	L	"	"	"	5.0V	H	"	L	"	"	"														
		47	"	"	"	H	H	L	"	"	"	5.0V	H	"	L	5.0V	"	"														
		48	"	"	"	H	H	L	"	"	"	GND	H	"	L	5.0V	"	"														
		49	GND	5.0V	5.0V	H	H	L	GND	"	5.0V	GND	H	GND	L	GND	"	"														
		50	"	"	"	L	L	H	"	"	"	5.0V	L	"	H	"	"	"														
		51	"	"	"	L	L	H	"	"	"	GND	L	"	H	"	"	"														
		52	"	"	"	L	L	H	"	"	"	5.0V	L	"	H	"	"	"														
		53	"	"	"	L	L	H	"	"	"	5.0V	L	"	H	5.0V	"	"														
		54	"	"	"	L	L	H	"	"	"	GND	L	"	H	5.0V	"	"														
		55	5.0V	GND	"	L	H	H	"	"	"	5.0V	L	"	H	GND	"	"														
		56	"	GND	"	L	H	H	"	"	"	GND	L	"	H	GND	"	"														
		57	"	GND	"	H	L	H	"	"	"	GND	H	"	L	5.0V	"	"														
		58	"	5.0V	GND	H	L	H	"	"	"	5.0V	L	"	H	GND	"	"														
		59	"	5.0V	GND	H	L	H	"	"	"	5.0V	L	"	H	5.0V	"	"														
		60	"	5.0V	GND	H	L	H	"	"	"	GND	L	"	H	5.0V	"	"														
		61	GND	"	"	H	H	H	"	"	"	"	H	"	H	5.0V	5.0V	"														
		62	"	"	"	H	H	H	"	"	"	"	H	"	H	GND	"	"														
		63	"	"	"	H	H	H	"	"	"	"	H	"	H	5.0V	"	"														
		64	"	"	"	H	H	H	"	"	"	"	H	"	H	GND	"	"														
		65	"	"	"	H	H	H	"	"	"	"	H	"	H	5.0V	"	"														

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 52 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 1/																Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C		Subgroup 11 T _C = -55°C		
			DATA	JAM 1	JAM 2	Q2	Q1	Q3	JAM 3	V _{SS}	JAM 4	PRESET ENABLE	Q4	JAM 5	Q5	CLOCK	RESET	V _{DD}		Min	Max	Min	Max	Min	Max	
t _{PHL1} 6/ t _{PHL1}	3003	66 67	IN "	GND "	GND "	OUT "	OUT "	OUT "	GND "	GND "	GND "	GND "	OUT "	GND "	OUT "	IN "	GND "	5.0V "	CLOCK TO OUTPUT	13 13	700 700	18 18	980 980	13 13	700 700	ns "
t _{PLH1} t _{PLH1}	"	68 69	" "	" "	" "	OUT "	OUT "	OUT "	" "	" "	" "	" "	OUT "	" "	OUT "	" "	" "	" "	CLOCK TO OUTPUT	13 13	700 700	18 18	980 980	13 13	700 700	" "
t _{PLH2} t _{PLH2}	"	70 71	" "	" "	" "	OUT "	OUT "	OUT "	" "	" "	" "	" "	OUT "	" "	OUT "	" "	IN IN	" "	RESET TO OUTPUT	13 13	700 700	18 18	980 980	13 13	700 700	" "
t _{THL} t _{THL}	3004	72 73	" "	" "	" "	OUT "	OUT "	OUT "	" "	" "	" "	" "	OUT "	" "	OUT "	" "	GND "	" "	OUTPUT	10 10	250 250	14 14	350 350	10 10	250 250	" "
t _{TLH} t _{TLH}	"	74 75	" "	" "	" "	OUT "	OUT "	OUT "	" "	" "	" "	" "	OUT "	" "	OUT "	IN "	GND "	" "	OUTPUT OUTPUT	10 10	250 250	14 14	350 350	10 10	250 250	" "
t _{SHL1} 6/ t _{SHL2}		76 77	" "	" "	" "	" "	" "	" "	" "	" "	" "	" "	IN "	" "	" "	" "	" "	" "	PRESET TO CLOCK		400		560		400	" "
t _{SHL3}		78	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	IN	RESET TO CLOCK		400		560		400	"
t _{SLH3}		79	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	GND	DATA TO CLOCK		200		280		200	"
t _{SLH3}		79	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	GND	DATA TO CLOCK		200		280		200	"

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 53.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 1/																Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 1 T _c = 25°C		Subgroup 2 T _c = 125°C		Subgroup 3 T _c = -55°C		
			Test no.	Q12	Q13	Q14	Q6	Q5	Q7	Q4	V _{SS}	Q1	CLOCK	RESET	Q9	Q8	Q10	Q11		V _{DD}	Min	Max	Min	Max	Min	
V _{IC} (POS)		1										1mA	1mA					GND	EACH INPUT		1.5					V
V _{IC} 2/ (NEG)		2										GND	-1mA	-1mA					EACH INPUT		-6					V
I _{IL1} 5/	3009	3										GND	GND					18.0V	ALL INPUTS TOGETHER		-200.0					nA
I _{IL2}	3009	4										GND	GND						EACH INPUT		-100.0		-100.0			"
I _{IH1}	3010	5										18.0V	18.0V						ALL INPUTS TOGETHER		200.0					"
I _{IH2}	3010	6										18.0V	18.0V						EACH INPUT		100.0		100.0			"
I _{OL}		7	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	4/	EACH OUTPUT	4/	4/	4/	4/	4/	4/	mA
I _{OH}		8	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	mA
V _{OL}	3007	9	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V
V _{QH}	3006	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"
V _{IL}		11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"
V _{IH}		12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"
I _{SS} 5/	3005	13										GND	18.0V					18.0V	V _{SS}		-1.0		-10.0			μA
	"	14										GND	GND					"	V _{SS}		"		"			"
	"	15										PU	PU					"	None		"		"			"
	"	16										GND	GND					"	V _{SS}		"		"			"
	"	17										PU	PU					"	None		"		"			"
	"	18										18.0V	18.0V					"	V _{SS}		"		"			"
																			Subgroup 4 T _c = 25°C							
																			Min	Max						
C _i 3/		19										GND	IN	IN				GND	EACH INPUT		12					pF

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 53 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z	Terminal conditions 1/														Measured terminal	Limits						Unit			
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		15	16	Subgroup 7		Subgroup 8					
			Test no.	Q12	Q13	Q14	Q6	Q5	Q7	Q4	V _{SS}	Q1	CLOCK	RESET	Q9	Q8		Q10	Q11	V _{DD}	T _C = 25°C		T _C = 125°C		T _C = -55°C		
																					Min	Max	Min		Max	Min	Max
Truth table test 5/	3014	20	L	L	L	L	L	L	L	GND	L	GND	5.0V	L	L	L	L	5.0V	EACH OUTPUT								
		21	L	L	L	L	L	L	L	"	L	GND	GND	L	L	L	L	"									
		22	L	L	L	L	L	L	L	"	L	5.0V	"	L	L	L	L	"									
		23	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		24	L	L	L	L	L	L	L	"	L	5.0V	"	L	L	L	L	"									
		25	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		26	X	X	X	X	X	X	X	"	X	PE	"	X	X	X	X	"									
		27	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		28	L	L	L	L	L	L	L	"	H	GND	"	L	L	L	L	"									
		29	X	X	X	X	X	X	X	"	X	PF	"	X	X	X	X	"									
		30	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		31	L	L	L	L	L	L	L	"	H	GND	"	L	L	L	L	"									
		32	X	X	X	X	X	X	X	"	X	PG	"	X	X	X	X	"									
		33	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		34	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		35	X	X	X	X	X	X	X	"	X	PH	"	X	X	X	X	"									
		36	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		37	L	L	L	L	L	L	L	"	H	GND	"	L	L	L	L	"									
		38	X	X	X	X	X	X	X	"	X	PJ	"	X	X	X	X	"									
		39	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		40	X	X	X	X	X	X	X	"	X	GND	"	L	L	L	L	"									
		41	X	X	X	X	X	X	X	"	X	PL	"	X	X	X	X	"									
		42	L	L	L	L	L	L	L	"	H	5.0V	"	L	L	L	L	"									
		43	L	L	L	L	L	L	L	"	L	GND	"	H	L	L	L	"									
		44	X	X	X	X	X	X	X	"	X	PM	"	X	X	X	X	"									
		45	L	L	L	L	L	L	L	"	H	5.0V	"	H	H	L	L	"									
		46	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		47	X	X	X	X	X	X	X	"	X	PN	"	X	X	X	X	"									
		48	L	L	L	L	L	L	L	"	H	5.0V	"	H	H	H	L	"									
		49	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	H	"									
		50	X	X	X	X	X	X	X	"	X	PR	"	X	X	X	X	"									
		51	L	L	L	L	L	L	L	"	H	5.0V	"	H	H	H	H	"									
		52	H	L	L	L	L	L	L	"	X	GND	"	L	L	L	L	"									
		53	X	X	X	X	X	X	X	"	X	PS	"	X	X	X	X	"									
		54	H	L	L	L	L	L	L	"	H	5.0V	"	H	H	H	H	"									
		55	L	H	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		56	X	X	X	X	X	X	X	"	X	PT	"	X	X	X	X	"									
		57	H	H	L	L	L	L	L	"	H	5.0V	"	H	H	H	H	"									
		58	L	L	H	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		59	X	X	X	X	X	X	X	"	X	PV	"	X	X	X	X	"									
		60	H	H	H	H	H	H	H	"	H	5.0V	"	H	H	H	H	"									
		61	L	L	L	L	L	L	L	"	L	GND	"	L	L	L	L	"									
		62	X	X	X	X	X	X	X	"	X	PY	"	X	X	X	X	"									
		63	H	L	L	L	L	L	L	"	L	GND	"	L	H	H	L	"									
		64	L	L	L	L	L	L	L	"	L	GND	5.0V	L	L	L	L	"									
		65	L	L	L	L	L	L	L	"	L	GND	GND	L	L	L	L	"									
		66	X	X	X	X	X	X	X	"	X	PU	"	X	X	X	X	"									
		67	L	L	L	L	L	L	L	"	H	GND	GND	H	L	L	H	"									
		68	L	L	L	L	L	L	L	"	L	GND	5.0V	L	L	L	L	"									
		69	L	L	L	L	L	L	L	"	L	GND	GND	L	L	L	L	"									

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 53 – Continued.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 1/																Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C		Subgroup 11 T _C = -55°C		
			Q12	Q13	Q14	Q6	Q5	Q7	Q4	V _{SS}	Q1	CLOCK	RESET	Q9	Q8	Q10	Q11	V _{DD}		Min	Max	Min	Max	Min	Max	
t _{PHL1} 6/	3003	70																5.0V	CLOCK TO OUTPUT	.013	0.55	.018	0.77	.013	0.55	μs
	"	71								OUT	"	"	"					"	"	.052	1.54	.072	2.15	.052	1.54	"
	"	72									"	"	"					"	"	.065	1.87	.090	2.62	.065	1.87	"
	"	73					OUT	OUT			"	"	"					"	"	.078	2.20	.108	3.08	.078	2.20	"
	"	74				OUT					"	"	"					"	"	.091	2.53	.126	3.54	.091	2.53	"
	"	75						OUT			"	"	"					"	"	.104	2.86	.144	4.00	.104	2.86	"
	"	76									"	"	"	OUT	OUT			"	"	.117	3.19	.162	4.47	.117	3.19	"
	"	77									"	"	"			OUT		"	"	.130	3.52	.180	4.93	.130	3.52	"
	"	78									"	"	"				OUT	"	"	.143	3.85	.198	5.39	.143	3.85	"
	"	79	OUT								"	"	"					"	"	.156	4.18	.216	5.85	.156	4.18	"
	"	80		OUT							"	"	"					"	"	.169	4.51	.234	6.31	.169	4.51	"
	"	81			OUT						"	"	"					"	"	.182	4.84	.252	6.78	.182	4.84	"
t _{PLH1}	"	82								OUT	"	OUT	"	"				"	"	.013	0.55	.018	0.77	.013	0.55	"
	"	83									"	"	"					"	"	.052	1.54	.072	2.15	.052	1.54	"
	"	84									"	"	"					"	"	.065	1.87	.090	2.62	.065	1.87	"
	"	85				OUT	OUT				"	"	"					"	"	.078	2.20	.108	3.08	.078	2.20	"
	"	86						OUT			"	"	"					"	"	.091	2.53	.126	3.54	.091	2.53	"
	"	87									"	"	"					"	"	.104	2.86	.144	4.00	.104	2.86	"
	"	88									"	"	"	OUT	OUT			"	"	.117	3.19	.162	4.47	.117	3.19	"
	"	89									"	"	"			OUT		"	"	.130	3.52	.180	4.93	.130	3.52	"
	"	90									"	"	"				OUT	"	"	.143	3.85	.198	5.39	.143	3.85	"
	"	91	OUT								"	"	"					"	"	.156	4.18	.216	5.85	.156	4.18	"
	"	92		OUT							"	"	"					"	"	.169	4.51	.234	6.31	.169	4.51	"
	"	93			OUT						"	"	"					"	"	.182	4.84	.252	6.78	.182	4.84	"
t _{PHL2}		94	OUT	OUT	"	OUT	OUT	OUT	OUT	OUT	"	OUT	"	IN	OUT	OUT	OUT	OUT	RESET TO OUTPUT	13	450	18	630	13	450	ns
t _{THL}	3004	95	"	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	OUTPUT	10	200	14	280	10	280	ns
t _{TLH}	3004	96	"	"	"	"	"	"	"	"	"	"	"	GND	"	"	"	"	OUTPUT	10	200	14	280	10	280	ns

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 54.

Symbol	MIL-STD-883 method	Cases E, F, N, Z Test no.	Terminal conditions 1/																Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C		
			1 OUT	0 OUT	2 OUT	5 OUT	6 OUT	NC	3 OUT	V _{SS}	NC	7 OUT	4 OUT	CARRY OUT	CLOCK ENABLE	CLOCK	RESET	V _{DD}		Min	Max	Min	Max	Min	Max	
V _{IC} (POS)		1												1 mA	1 mA	1 mA	GND	EACH INPUT		1.5					V	
V _{IC} (NEG)		2							GND					-1 mA	-1 mA	-1 mA		EACH INPUT		-6.0					V	
I _{IL1} 2/	3009	3												GND	GND	GND	18.0V	ALL INPUTS TOGETHER		-300.0					nA	
I _{IL2}	3009	4												GND	GND	GND		EACH INPUT		-100.0		-100.0			"	
I _{IH1}	3010	5												18.0V	18.0V	18.0V		ALL INPUTS TOGETHER		300.0					"	
I _{IH2}	3010	6												18.0V	18.0V	18.0V		EACH INPUT		100.0		100.0			"	
I _{OL}		7	4/	4/	4/	4/	4/		4/		4/	4/	4/	4/	4/	4/	4/	EACH OUTPUT	4/	4/	4/	4/	4/	4/	mA	
I _{OH}		8	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	mA	
V _{OL}	3007	9	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	V	
V _{OH}	3006	10	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	
V _{IL}		11	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"	
V _{IH}		12	"	"	"	"	"	"	"	"	"	"	"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"	
I _{SS} 5/	3005	13												GND	GND	18.0V	18.0V	V _{SS}		-0.5		-5.0			μA	
"	"	14												"	GND	"	"	V _{SS}		"		"			"	
"	"	15												"	18.0V	"	"	None		"		"			"	
"	"	16												"	GND	"	"	V _{SS}		"		"			"	
"	"	17												"	18.0V	"	"	None		"		"			"	
"	"	18												"	GND	"	"	V _{SS}		"		"			"	
"	"	19												"	18.0V	"	"	None		"		"			"	
"	"	20												"	GND	"	"	V _{SS}		"		"			"	
"	"	21												"	18.0V	"	"	V _{SS}		"		"			"	
"	"	22												"	GND	"	"	None		"		"			"	
"	"	23												"	18.0V	"	"	V _{SS}		"		"			"	
"	"	24												"	GND	"	"	None		"		"			"	
"	"	25												"	18.0V	"	"	V _{SS}		"		"			"	
"	"	26												"	GND	"	"	None		"		"			"	
"	"	27												"	18.0V	"	"	V _{SS}		"		"			"	
"	"	28												18.0V	18.0V	"	"	V _{SS}		"		"			"	

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 55.

Symbol	MIL-STD-883 method	Cases A,B,C,D T,X,Y	Terminal conditions 1/														Measured terminal	Limits						Unit
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		Subgroup 1 T _C = 25°C		Subgroup 2 T _C = 125°C		Subgroup 3 T _C = -55°C		
			Test no.	CLOCK	RESET	Q7	Q6	Q5	Q4	V _{SS}	NC	Q3	NC	Q2	Q1	NC		V _{DD}	Min	Max	Min	Max	Min	
V _{IC} (POS)		1	1 mA	1 mA												GND	EACH INPUT	1.5					V	
V _{IC} (NEG)		2	-1 mA	-1 mA												GND	EACH INPUT	-6.0					V	
I _{IL} 2/ I _{IL}	3009	3	GND	GND												18.0V	CLOCK	-100.0		-100.0			nA	
	3009	4	GND	GND												"	RESET	-100.0		-100.0			"	
I _{IH} I _{IH}	3010	5	18.0V	GND												"	CLOCK	100.0		100.0			"	
	3010	6	GND	18.0V												"	RESET	100.0		100.0			"	
I _{OL}		7	4/	4/	4/	4/	4/	4/	4/	"		4/		4/	4/	4/	EACH OUTPUT	4/	4/	4/	4/	4/	4/	mA
I _{OH}		8	"	"	"	"	"	"	"	"		"	"	"	"	"	"	"	"	"	"	"	"	mA
V _{OL}	3007	9	"	"	"	"	"	"	"	"		"	"	"	"	"	"	"	"	"	"	"	"	V
V _{OH}	3006	10	"	"	"	"	"	"	"	"		"	"	"	"	"	"	"	"	"	"	"	"	"
V _{IL}		11	"	"	"	"	"	"	"	"		"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"
V _{IH}		12	"	"	"	"	"	"	"	"		"	"	"	"	"	EACH INPUT	"	"	"	"	"	"	"
I _{SS} 5/	3005	13	GND	18.0V						"						18.0V	V _{SS}	-0.5		-5.0			μA	
	"	14	GND	GND						"						"	V _{SS}	"		"			"	
	"	15	PI	"						"						"	None	"		"			"	
	"	16	18.0V	"						"						"	V _{SS}	"		"			"	
	"	17	GND	"						"						"	None	"		"			"	
	"	18	PI	"						"						"	None	"		"			"	
"	19	GND	"						"						"	V _{SS}	"		"			"		
																	Subgroup 4 T _C = 25°C							
																	Min	Max						
C _i 3/	3012	20	IN	IN						GND						GND	EACH INPUT		12					pF

See footnotes at end of device type 55.

TABLE III. Group A inspection for device type 55 – Continued.

Symbol	MIL-STD-883 method	Cases A,B,C,D T,X,Y	Terminal conditions 1/														Measured terminal	Limits						Unit									
			1	2	3	4	5	6	7	8	9	10	11	12	13	14		Subgroup 7 T _C = 25°C		Subgroup 8													
			CLOCK	RESET	Q7	Q6	Q5	Q4	V _{SS}	NC	Q3	NC	Q2	Q1	NC	V _{DD}		Min	Max	T _C = 125°C		T _C = -55°C											
			Test no.																	Min	Max	Min	Max		Min	Max							
Truth table test 5/	3014	21	GND	5.0V	L	L	L	L	L	GND		L		L	L	L	5.0V	EACH OUTPUT															
		22	GND	GND	L	L	L	L	L	"		L		L	L	L	"																
		23	5.0V	"	L	L	L	L	L	"		L		L	L	L	"																
		24	GND	"	L	L	L	L	L	"		L		L	L	H	"																
		25	5.0V	"	L	L	L	L	L	"		L		L	L	H	"																
		26	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		27	5.0V	"	L	L	L	L	L	"		L		L	L	L	"																
		28	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		29	5.0V	"	L	L	L	L	L	"		L		L	L	L	"																
		30	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		31	PC	"	X	X	X	X	X	"		X		X	X	X	"																
		32	5.0V	"	L	L	L	L	L	"		H		H	H	H	"																
		33	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		34	PF	"	X	X	X	X	X	"		X		X	X	X	"																
		35	5.0V	"	L	L	L	L	L	"		H		H	H	H	"																
		36	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		37	PG	"	X	X	X	X	X	"		X		X	X	X	"																
		38	5.0V	"	L	L	L	L	L	"		H		H	H	H	"																
		39	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		40	PH	"	X	X	X	X	X	"		X		X	X	X	"																
		41	5.0V	"	L	L	L	L	L	"		H		H	H	H	"																
		42	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		43	PJ	"	X	X	X	X	X	"		X		X	X	X	"																
		44	5.0V	"	H	H	H	H	H	"		H		H	H	H	"																
		45	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		46	PI	"	X	X	X	X	X	"		X		X	X	X	"																
		47	GND	"	L	L	L	L	L	"		L		L	L	L	"																
		48	GND	5.0V	L	L	L	L	L	"		L		L	L	L	"																
		49	GND	GND	L	L	L	L	L	"		L		L	L	L	"																
		50	PK	GND	X	X	X	X	X	"		X		X	X	X	"																
		51	GND	GND	H	L	L	L	L	"		H		L	L	L	"																
		52	GND	5.0V	L	L	L	L	L	"		L		L	L	L	"																
		53	GND	GND	L	L	L	L	L	"		L		L	L	L	"																
																									Subgroup 9 T _C = 25°C		Subgroup 10 T _C = 125°C		Subgroup 11 T _C = -55°C				
		t _{PHL1} 6/	3003	54	IN	GND					GND				OUT	OUT									5.0V	CLOCK TO OUTPUT	.013	0.35	.018	0.49	.013	0.35	μs
				55	"	"					"				OUT	OUT									"	"	.026	0.55	.036	0.77	.026	0.55	"
				56	"	"					"				OUT	OUT									"	"	.039	0.75	.054	1.05	.039	0.75	"
				57	"	"					"				OUT	OUT									"	"	.052	0.95	.072	1.33	.052	0.95	"
				58	"	"					"				OUT	OUT									"	"	.065	1.15	.090	1.61	.065	1.15	"
				59	"	"					"				OUT	OUT									"	"	.078	1.35	.108	1.89	.078	1.35	"
				60	"	"	OUT	OUT	OUT	OUT	"			OUT	OUT		"								"	.091	1.55	.126	2.17	.091	1.55	"	
		t _{PLH1}	"	61	"	"					"				OUT	OUT									"	"	.013	0.35	.018	0.49	.013	0.35	"
				62	"	"					"				OUT	OUT									"	"	.026	0.55	.036	0.77	.026	0.55	"
				63	"	"					"				OUT	OUT									"	"	.039	0.75	.054	1.05	.039	0.75	"
				64	"	"					"				OUT	OUT									"	"	.052	0.95	.072	1.33	.052	0.95	"
				65	"	"					"				OUT	OUT									"	"	.065	1.15	.090	1.61	.065	1.15	"
				66	"	"					"				OUT	OUT									"	"	.078	1.35	.108	1.89	.078	1.35	"
				67	"	"	OUT	OUT	OUT	OUT	"			OUT	OUT		"								"	.091	1.55	.126	2.17	.091	1.55	"	
		t _{PHL2}	"	68	"	IN	OUT	OUT	OUT	OUT	"			OUT	OUT		"								RESET TO OUTPUT	13	350	18	490	13	350	ns	
		t _{THL}	3004	69	"	GND	"	"	"	"	"			"	"		"								OUTPUT	10	200	14	280	10	200	ns	
		t _{TLH}	3004	70	"	GND	"	"	"	"	"			"	"		"								OUTPUT	10	200	14	280	10	200	ns	

See footnotes on next page.

- 1/ Pins not designated may be high-level logic, low-level logic, or open. Exceptions are as follows:
- $V_{IC}(\text{POS})$ tests, the V_{SS} terminal shall be open.
 - $V_{IC}(\text{NEG})$ tests, the V_{DD} terminal shall be open.
 - I_{SS} tests, the output terminal shall be open.
- 2/ The device manufacturer may, at his option, measure I_{IL} and I_{IH} at 25°C for each individual input or measure all inputs together.
- 3/ See 4.4.1c for C_i measurement.
- 4/ Procedures for input/output tests of the device parameters specified below are described in figures 4, 5, 6, and 7. Included with the specified parameters are test conditions and test limits at three temperatures. These tests shall be performed at each specified V_{DD} voltage at the specified conditions. V_{IL}/V_{IH} test maybe performed as final attributes data.

Symbol	Parameter	V_{DD} (V dc)	Conditions	Limits						Unit
				$T_C = -55^\circ\text{C}$		$T_C = 25^\circ\text{C}$		$T_C = 125^\circ\text{C}$		
				Min	Max	Min	Max	Min	Max	
V_{OL}	Low-level output voltage	15	$V_I = V_{SS}$ or V_{DD} $ I_O \leq 1 \mu\text{A}$		0.05		0.05		0.05	V
V_{OH}	High-level output voltage	15	$V_I = V_{SS}$ or V_{DD} $ I_O \leq 1 \mu\text{A}$	14.95		14.95		14.95		V
V_{IL}	Input low voltage	5	$V_O = 0.5 \text{ V}$ or 4.5 V	1.5		1.5		1.5		V
		10	$V_O = 1.0 \text{ V}$ or 9.0 V	3.0		3.0		3.0		
		15	$V_O = 1.5 \text{ V}$ or 13.5 V $ I_O \leq 1 \mu\text{A}$	4.0		4.0		4.0		
V_{IH}	Input high voltage	5	$V_O = 0.5 \text{ V}$ or 4.5 V		3.5		3.5		3.5	V
		10	$V_O = 1.0 \text{ V}$ or 9.0 V		7.0		7.0		7.0	
		15	$V_O = 1.5 \text{ V}$ or 13.5 V $ I_O \leq 1 \mu\text{A}$		11.0		11.0		11.0	
I_{OL}	Output low (sink) current	5	$V_O = 0.4 \text{ V}$, $V_I = 0$ or 5 V	0.64		0.51		0.36		mA
		15	$V_O = 1.5 \text{ V}$, $V_I = 0$ or 15 V	4.2		3.4		2.4		
I_{OH}	Output high (source) current	5	$V_O = 4.6 \text{ V}$, $V_I = 0$ or 5 V	-0.64		-0.51		-0.36		mA
		15	$V_O = 13.5 \text{ V}$, $V_I = 0$ or 15 V	-4.2		-3.4		-2.4		

5/ This I_{SS} and truth table tests shall be performed in the test number sequence shown with no intervening changes to terminal conditions. The truth table tests shall be performed with V_{IH} and $V_{DD} \leq 5.0$ V and ≥ 18.0 V. Table III shows the lower of these two voltages. During the functional test, input terminals designated "PA", "PB", etc., shall have applied thereto a specified number of single pulses with the following parameters: Pulse amplitude = V_{DD} maximum to $V_{DD} = 4\%$ minimum. These pulses are enumerated as follows:

<u>Symbol</u>	<u>Pulses</u>	<u>Symbol</u>	<u>Pulses</u>	<u>Symbol</u>	<u>Pulses</u>	<u>Symbol</u>	<u>Pulses</u>
PA	1	PF	7	PK	85	PS	2047
PB	2	PG	15	PL	127	PT	4095
PC	3	PH	31	PM	255	PU	5461
PD	4	PI	42	PN	511	PV	8191
PE	5	PJ	63	PR	1023	PY	10922

Also during the truth table tests, device output voltages are: don't care "X", high "H", and low "L" as specified in the terminal conditions columns. The output voltage limits over the specified temperature range are "H" = $V_{DD} - 0.50$ V minimum and "L" = $V_{SS} + 0.50$ V maximum.

6/ See figure 8 for switching time waveforms and test circuit.

7/ Data pin need only be toggled high or low to allow outputs to achieve the proper setup state required to verify the indicated test parameter.

4.4.4 Group D inspection. Group D inspection shall be in accordance with table V of MIL-PRF-38535. End-point electrical parameters shall be as specified in table II herein.

4.4.5 Group E inspection. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.7 herein). RHA levels for device classes B and S shall be as specified in MIL-PRF-38535 and 4.5.4 herein.

4.5 Methods of inspection. Methods of inspection shall be specified and as follows:

4.5.1 Voltage and current. Unless otherwise specified, all voltages given are referenced to the microcircuit V_{SS} terminal. Currents given are conventional current and positive when flowing into the referenced terminal.

4.5.2 Burn-in and life test cool down procedures. When the burn-in and life tests are completed and prior to removal of bias voltages, the devices under test (DUT) shall be cooled to a temperature of $25^{\circ}\text{C} \pm 3^{\circ}\text{C}$; then, electrical parameter end-point measurements shall be performed.

TABLE IV. Delta limits at 25°C .

Parameter 1/	V_{DD}	Device types				
		01	02	03	04	05
I_{SS}	15 V	± 125 nA	± 125 nA	± 250 nA	± 125 nA	± 125 nA
V_{OL1}	5 V	± 0.04 V	± 0.04 V	± 0.04 V	± 0.04 V	± 0.04 V
V_{OH1}	5 V	± 0.08 V	± 0.08 V	± 0.08 V	± 0.08 V	± 0.08 V

Parameter 1/	V_{DD}	Device types				
		51	52	53	54	55
I_{SS}	18 V	± 125 nA	± 125 nA	± 250 nA	± 125 nA	± 125 nA
I_{OL}	5 V	$\pm 15\%$				
I_{OH}	5 V	$\pm 15\%$				

1/ Each of the above parameters shall be recorded before and after the required burn-in and life tests to determine delta (Δ).

4.5.3 Quiescent supply current (I_{SS} test). When performing quiescent supply current measurements (I_{SS}), the meter shall be placed so that all currents flow through the meter.

4.5.4 Radiation hardness assurance (RHA) testing. The RHA testing shall be performed in accordance with test procedures and sampling specified in MIL-PRF-38535 and herein.

- Before irradiation, selected samples shall be assembled in qualified packages and pass the governing electrical parameters (group A subgroup 1 at 25°C) and also be subjected to the threshold-voltage test in table VII in order to calculate the delta threshold (ΔV_T) after irradiation.
- The devices shall be subjected to a total radiation dose as specified in MIL-PRF-38535 for the radiation hardness assurance level being tested, and meet the end-point electrical parameters as defined in table V at 25°C , after exposure. The start and completion of the end-point electrical parameter measurements shall not exceed 2 hours following irradiation.
- Threshold-voltage test circuit conditions shall be as specified in table VII and on figure 9. In situ and remote testing, the tests shall be performed with the devices biased in accordance with table VI and the bias may be interrupted for up to 1 minute to remove devices to the remote bias fixture.
- After irradiation, the devices shall pass the truth table test as specified in subgroup 7 in table III or if subgroup 7 is not required, then an equivalent truth table test shall be performed.

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TABLE V. Radiation hardened end-point electrical parameters at 25°C.

Parameter	Test limits (All device types)	V_{DD}	
		Device types	
		01-05	51-55
V_{TN}	0.3 V min	10 V	10 V
V_{TP}	2.8 V max	10 V	10 V
ΔV_T	1.4 V max	10 V	10 V
I_{SS}	100 x max limit	15 V	18 V
t_{PLH}	1.35 x max limit	5 V	5 V
t_{PHL}	1.35 x max limit	5 V	5 V

TABLE VI. Bias during exposure to radiation.

Device type	Pin connections ^{1/}		
	$V_{DD} = 10$ V dc (through a 30 k Ω to 60 k Ω resistor)	$V_{SS} = GND$	$V_{DD} = 10$ V dc
01, 51	13, 14, 15	8	16
02, 52	1, 2, 3, 7, 9, 10, 12, 14, 15	8	16
03, 53	10, 11	8	16
04, 54	13, 14, 15	8	16
05, 55	1, 2	7	14

^{1/} Pins not designated are open, or tied to 10 V dc through a 30 k Ω to 60 k Ω resistor.

5. PACKAGING

5.1 Packaging. For acquisition purposes, the packaging requirements are as specified in the contract or order (see 6.2). When actual packaging of material is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain requisite packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Department of Defense Agency, or within the military service's system command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

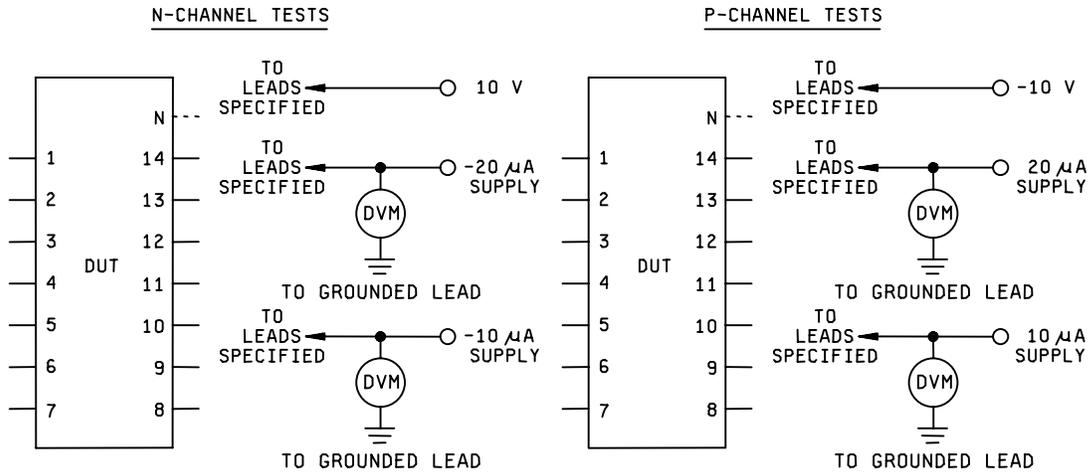


FIGURE 9. Threshold-voltage test circuit.

TABLE VII. Threshold-voltage test circuit conditions.

Device type	GND	10 V	V_{TN} measured at		GND	-10 V	V_{TP} measured at	
			-20 μ A supply	-10 μ A supply			20 μ A supply	10 μ A supply
01, 51	15	16		8, 13, 14	15	8		13, 14, 16
02, 52	15	16		1, 2, 3, 7-10, 12, 14	15	1, 2, 3, 7-10, 12, 14		16
03, 53	10	8, 11		8, 11	11	16		16
04, 54	14	13, 15, 16		8	14	8, 13, 15		16
05, 55	1	14		2, 7	1	2, 7		14

6. NOTES

6.1 Intended use. Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.

6.2 Acquisition requirements. Acquisition documents should specify the following:

- a. Title, number, and date of the specification.
- b. PIN and compliance identifier, if applicable (see 1.2).
- c. Requirements for delivery of one copy of the quality conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.
- d. Requirements for certificate of compliance, if applicable.
- e. Requirements for notification of change of product or process to contracting activity in addition to notification to the qualifying activity, if applicable.
- f. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.
- g. Requirements for product assurance and radiation hardness assurance options.
- h. Requirements for special carriers, lead lengths, or lead forming, if applicable. These requirements should not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.
- i. Requirements for "JAN" marking.
- j. Packaging requirements. (see 5.1)

6.3 Superseding information. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractors parts lists.

6.4 Qualification. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, P.O. Box 3990, Columbus, Ohio 43218-3990.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-HDBK-1331, and as follows:

C_I	Input terminal-to-GND capacitance.
GND	Ground zero voltage potential.
T_A	Free air temperature.
$V_{IC(pos)}$	Positive clamping input to V_{DD} .
$V_{IC(neg)}$	Negative clamping input to V_{SS} .
V_{ICL}	Clock input voltage.
V_{DD}	Positive supply voltage.
V_{SS}	Negative supply voltage.
I_{SS}	Quiescent supply current.

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6.6 Logistic support. Lead materials and finishes (see 3.4) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class S for National Aeronautics and Space Administration or class B for Department of Defense (see 1.2.2), lead material and finish A (see 3.4). Longer length leads and lead forming should not affect the part number.

6.7 Data reporting. When specified in the purchase order or contract, a copy of the following data, as applicable, will be supplied.

- a. Attributes data for all screening tests (see 4.2) and variables data for all static burn-in, dynamic burn-in, and steady-state life tests (see 3.6).
- b. A copy of each radiograph.
- c. The technology conformance inspection (TCI) data (see 4.4).
- d. Parameter distribution data on parameters evaluated during burn-in (see 3.6).
- e. Final electrical parameters data (see 4.2d).
- f. RHA delta limits.

6.8 Substitutability. The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges, post irradiation performance or reliability factors equivalent to MIL-M-38510 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Military device type	Generic-industry type
01	4017A
02	4018A
03	4020A
04	4022A
05	4024A
51	4017B
52	4018B
53	4020B
54	4022B
55	4024B

6.9 Changes from previous issue. Marginal notations are not used in this revision to identify changes with respect to the previous issue due to the extent of the changes.

Custodians:
 Army - CR
 Navy - EC
 Air Force - 11
 DLA - CC

Preparing activity:
 DLA - CC
 (Project 5962-2067)

Review activities:
 Army - MI, SM
 Navy - AS, CG, MC, SH, TD
 Air Force - 03, 19, 99

NOTE: The activities listed above were interested in this document as of the date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using ASSIST Online database at www.dodssp.daps.mil.